

RX72M Group

R01AN4885EJ0104

Rev.1.04

Aug. 31, 2021

Communications Board PROFINET Startup Manual

Introduction

This application note is a quick start guide for PROFINET communication with the RX72M communication board for industrial network evaluation.

This stack runs on E-Force's real-time OS "μC3 (micro-C-cube)" and TCP/IP protocol stack "μNet 3 (micro-net-cube)".

Target Device

RX72M Group

Sample program

This sample program uses the evaluation version of PROFINET stack of our partner: JSL Technology Co., Ltd.

Please contact JSL Technology Corporation for the purchase of the official version and the specifications of the sample program.

JSL Technology Co., Ltd. : <https://jslt.co.jp/>

【Restrictions】

The evaluation version of the PROFINETIP stack is a library file built with the following functional restrictions, and can only be used for evaluation. It cannot be used for integration into the product. In that case, please consider purchasing the official version.

- The PROFINET stack is provided as a library
- e-Force's real-time OS "μC3" uses a time-limited evaluation version

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1. Operating Environment

The sample program in this manual assumes the following environment.

Table 1.1 Operating Environment

Item	Description
Board	RX72M communications board TS-TCS07298 from Tesser Technology
CPU	RX CPU (RXv3) R5F572MNDxBD
Operating frequency	CPU clock (CPUCLK): 240 MHz
Operating voltage	3.3 V
Operating modes	<ul style="list-style-type: none"> • Single chip mode
Device requirements	R5F572MNDDBD <ul style="list-style-type: none"> • Code flash memory Capacity: 4 Mbytes ROM cache: 8 Kbytes • Data flash memory Capacity: 32 Kbytes • RAM/extended RAM Capacity: 512 Kbytes/512 Kbytes
Communications protocol	PROFINET (Version 5.4.3.0)
Available port	CN2, CN3
Integrated development environment	e2Studio V7.5.0 or later
Tool chain	C/C ++ compiler package V3.01.00 or later for RX family
Emulator (ICE)	Renesas E2 Lite

1.1 Stack compatible specifications

The supported stack specifications are as follows.

- PNIO Device Stack V5.4.3.0
- Test Bundle “2018-09-25_PN-test”対応

1.2 Sample program folder structure

The release folder structure is described below.

[pnet_dev]

|

|-[lib] : library

|

|-[prj_rx72m_e] : e² studio folder

|

|-[src] : Source folder

| |-[app]

| | |-[rx72m]

| | |-[Gsdmi] : PROFINET Stack Configuration Data

| | |-[uC3] : uC3 main, driver

2. Setting up and Connecting the Evaluation Board

For detailed information on the board, refer to the *RX72M Group Communications Board Hardware Manual*.

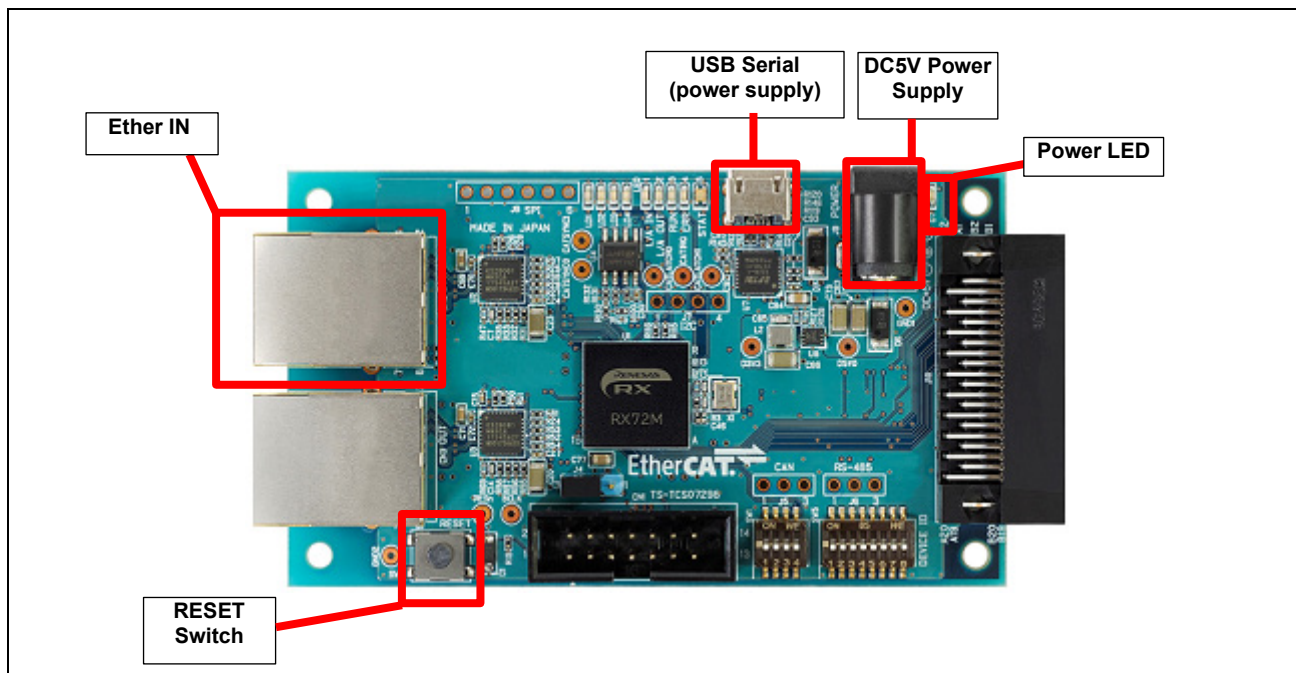


Figure 2.1 Configuration of the RX72M Communications Board

2.1 Setting up the Board

Before supplying power to the board, set up jumpers and connect the cables. In addition, make settings for the JTAG configuration mode. This mode is normally used with a short circuit between jumper pins 2 and 3.

For the detailed locations of the related parts, refer to the *RX72M Communications Board Hardware Manual*.

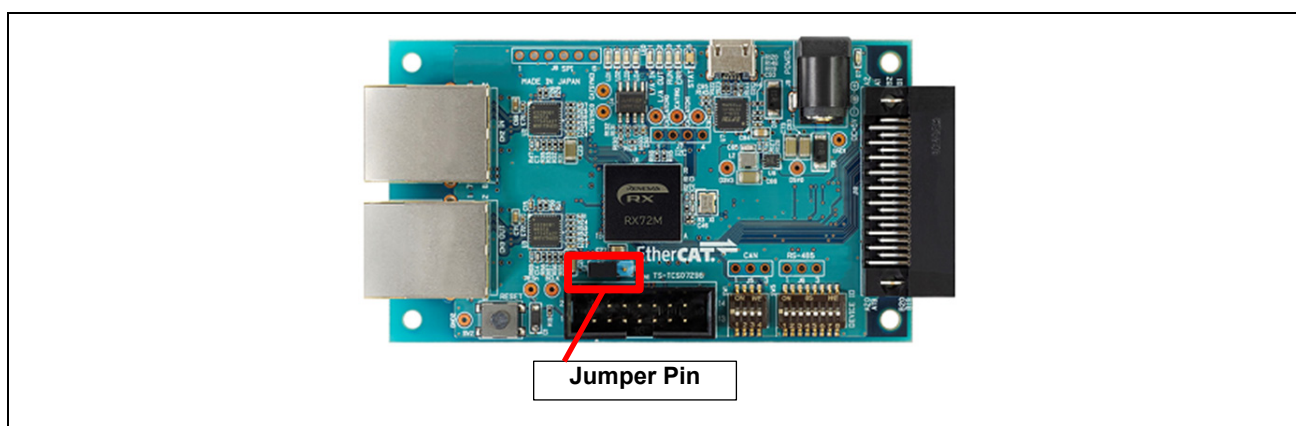


Figure 2.2 Setting up Jumper Pins

2.2 Selecting the Power Source

Power to the RX72M can be supplied from a 5-V DC power source or through the USB port. Use whichever is suitable for the configuration of your operating environment.

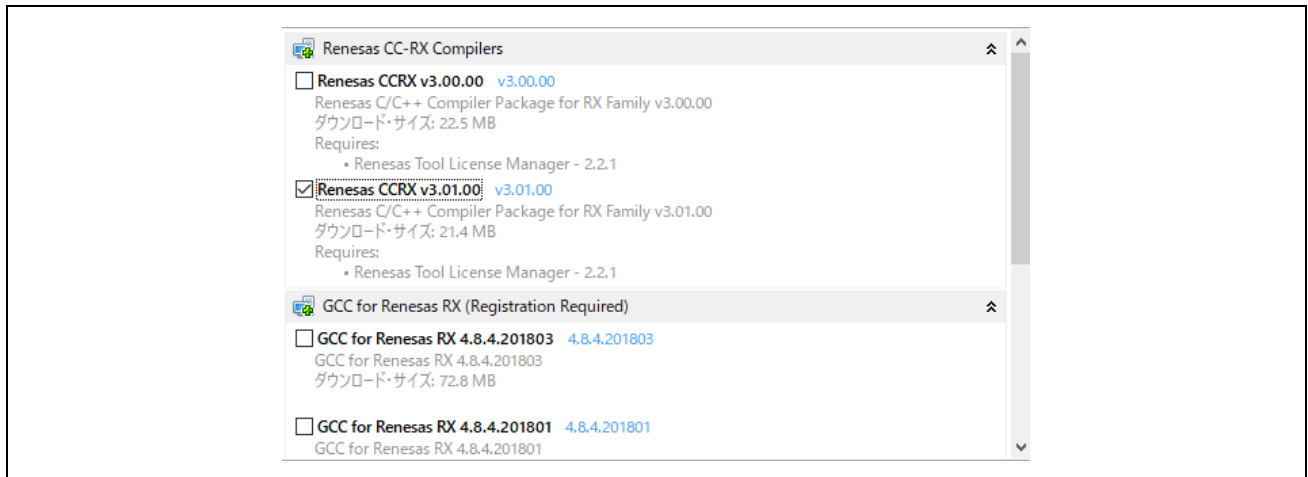
3. Installing the e² studio

Download RX72M compatible e2studio (V7.5.0 or later) from the following website.

https://www.renesas.com/e2studio_download

3.1 Installing the CC-RX Compiler V3.01.00

The compiler selection screen appears while installing e2studio. By selecting [Renesas CCRX v3.0 1.00] and selecting [Next], CC-RX V3.0 1.00 compiler compatible with RX72M will be installed together.



To start e2studio, please run "e2studio.exe" located in the installed folder below.

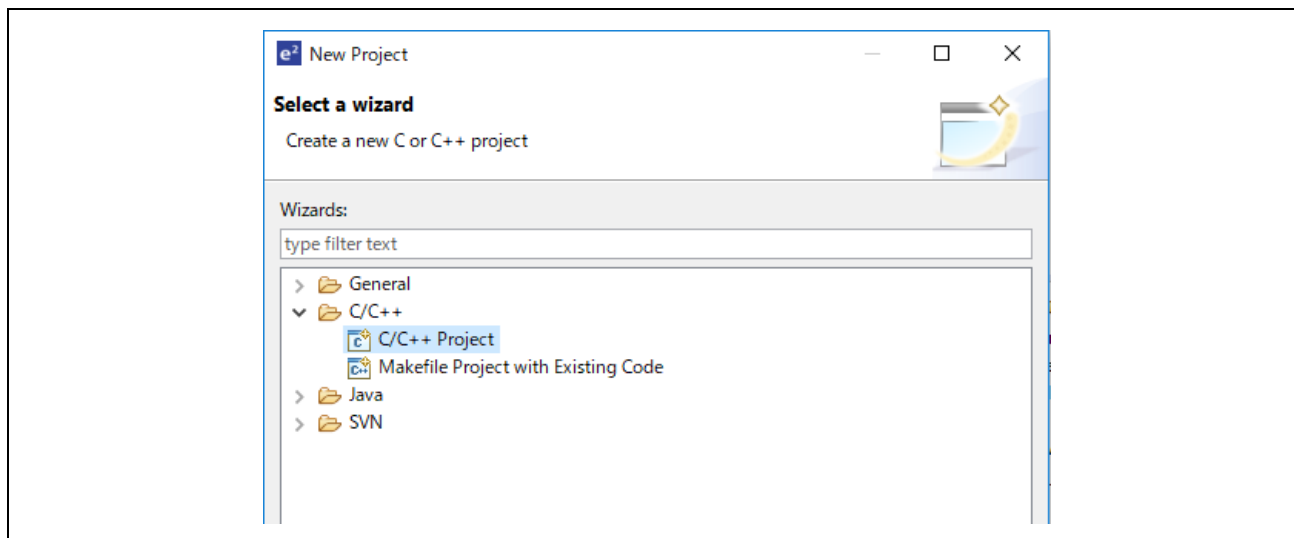
e2_studio_rx72m\eclipse

3.2 Registering the Tool Chain

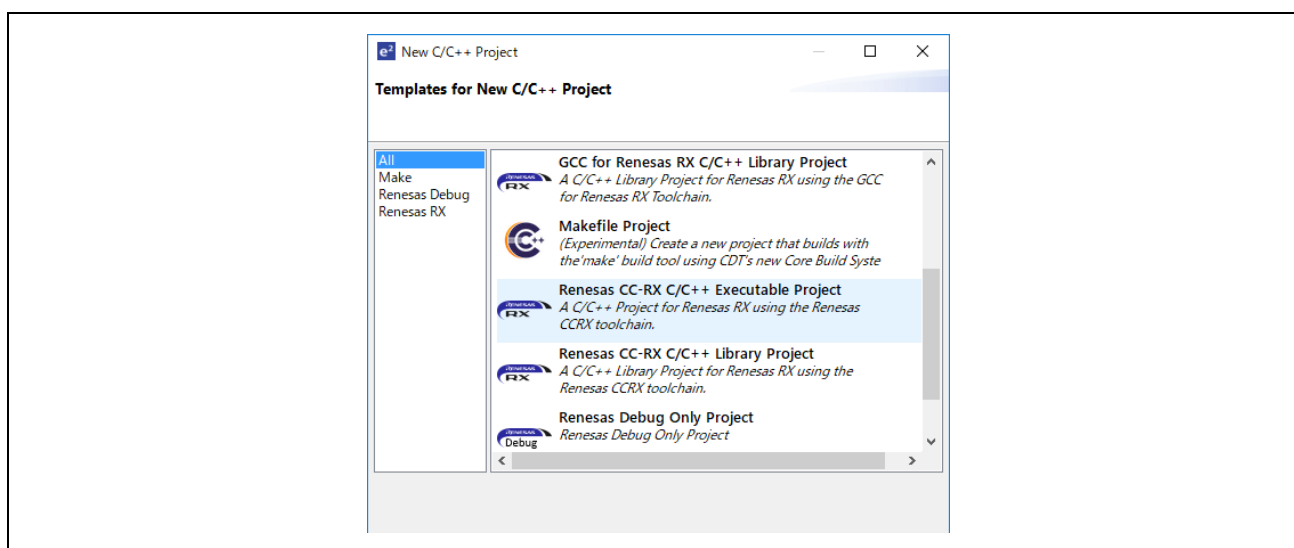
Register the CC-RX compiler v3.01.00 so that it can be used with the e² studio for RX72M.

(1) Start the e² studio for RX72M.

(2) Select [File] → [New] → [C/C++Project] → [Next].



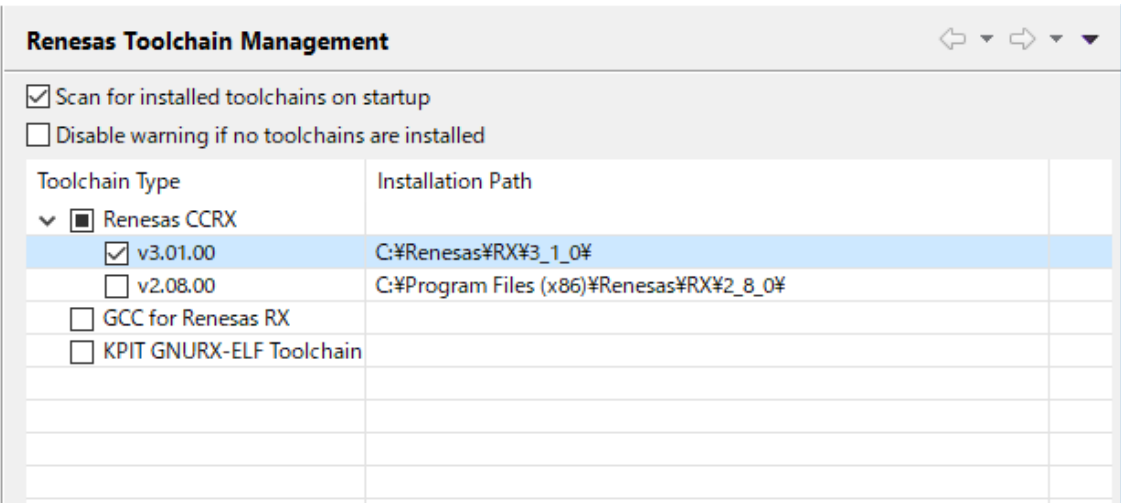
(3) In the [Templates for New C/C++ Project] dialog box, select [Renesas RX] → [Renesas CC-RX C/C++ Executable Project] → [Next].



(4) In the [New Renesas CC-RX C/C++ Executable Project] dialog box, enter a desired project name and select [Next].

(5) In the [Select toolchain, device & debug settings] dialog box, select [Toolchain Management] under [Toolchain Settings].

- (6) In the [Renesas Toolchain Management] dialog box, select [Add] → [Browse...] to refer to the installation folder "C:\Renesas\RXv3_0_1".
The registration was successful if "v3.01.00 has been added under "Renesas CCRX".



4. Evaluation environment construction method

The following describes method to build a development environment.

4.1 Preparing the evaluation environment

- (1) Preparing the environment folder

Release environment in an optional folder.

ex : C:\proj\pnet_dev

- (2) GSDML File

Use the GDSML file in the following folder for the GDSML file.

pnet_dev\src\app\rx72m\Gsmddl

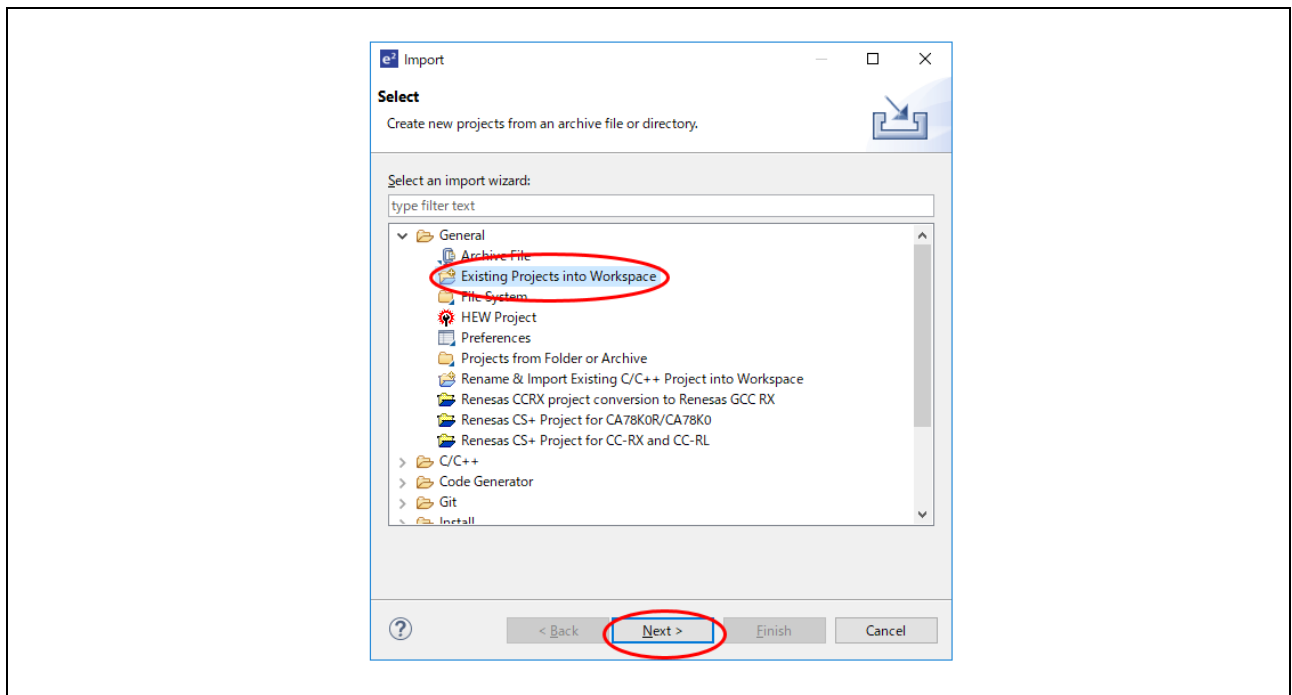
- GSDML-V2.33-Renesas_RX72M_Dev-Sample-20*****.xml

4.2 Execution procedure

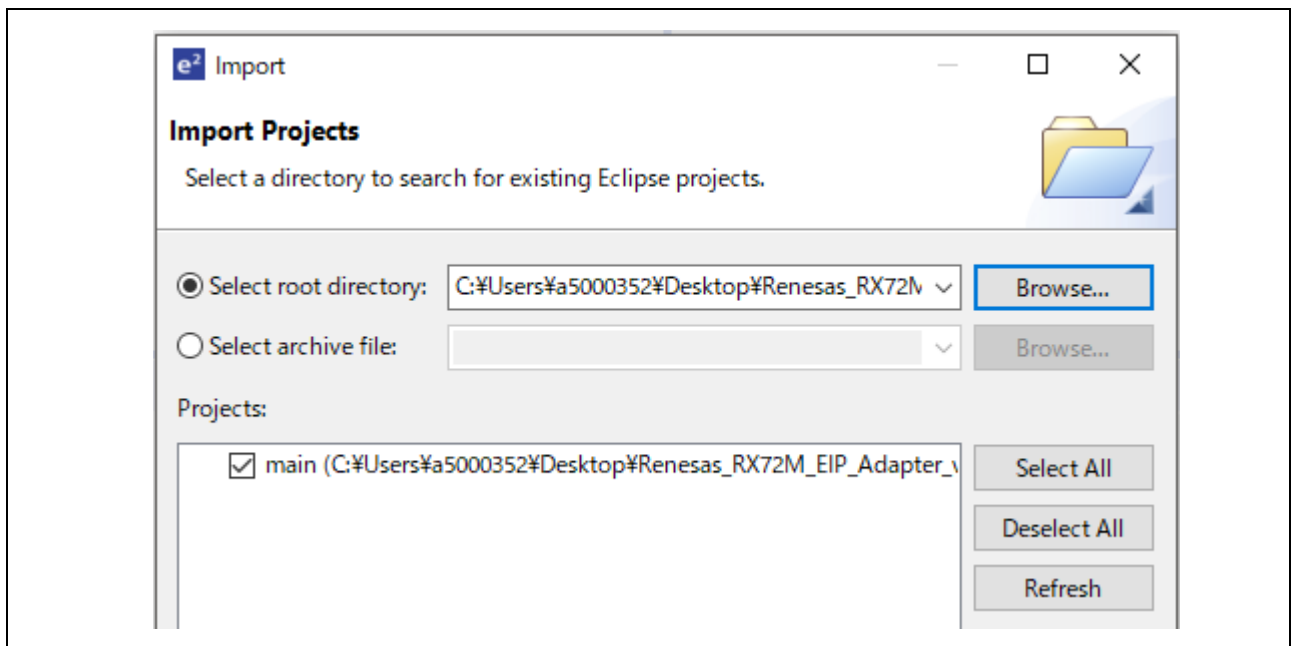
Describes the procedure to execute communication in the sample application.

- (1) After starting e2studio, click "File"-> "Import".

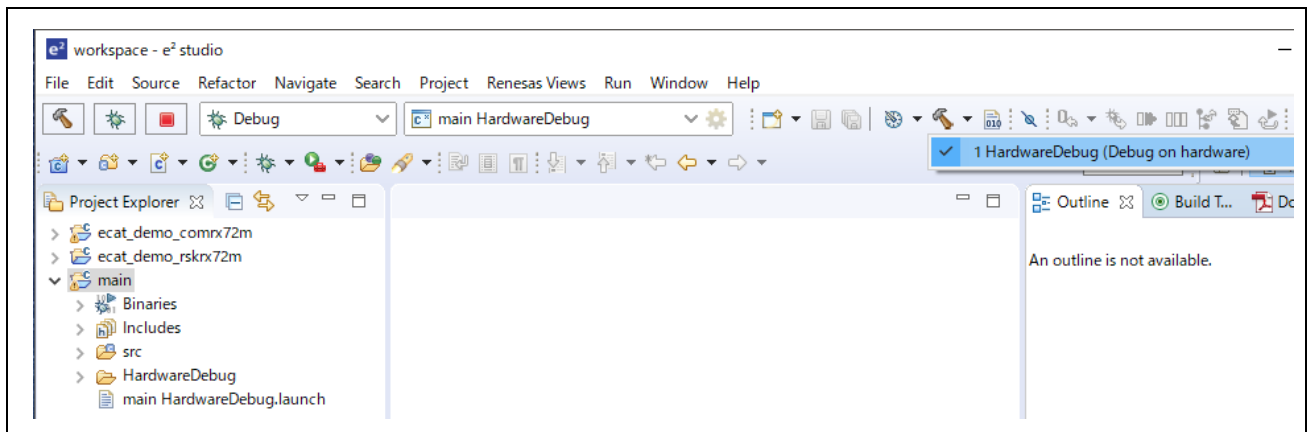
- (2) In the "Select" dialog, select "General" → "To an existing project to workspace" and click "Next".



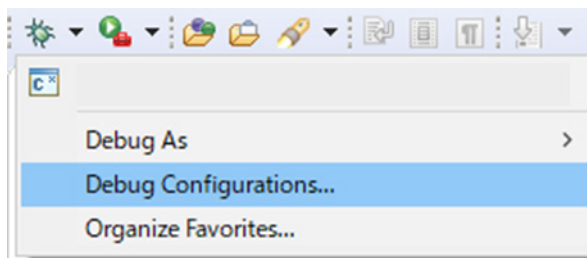
- (3) Select the "Select root directory" check box in the "Import project" dialog and click "Browse". Select "prj_rx72m_e" and click "Open". Click Finish to complete the project import.



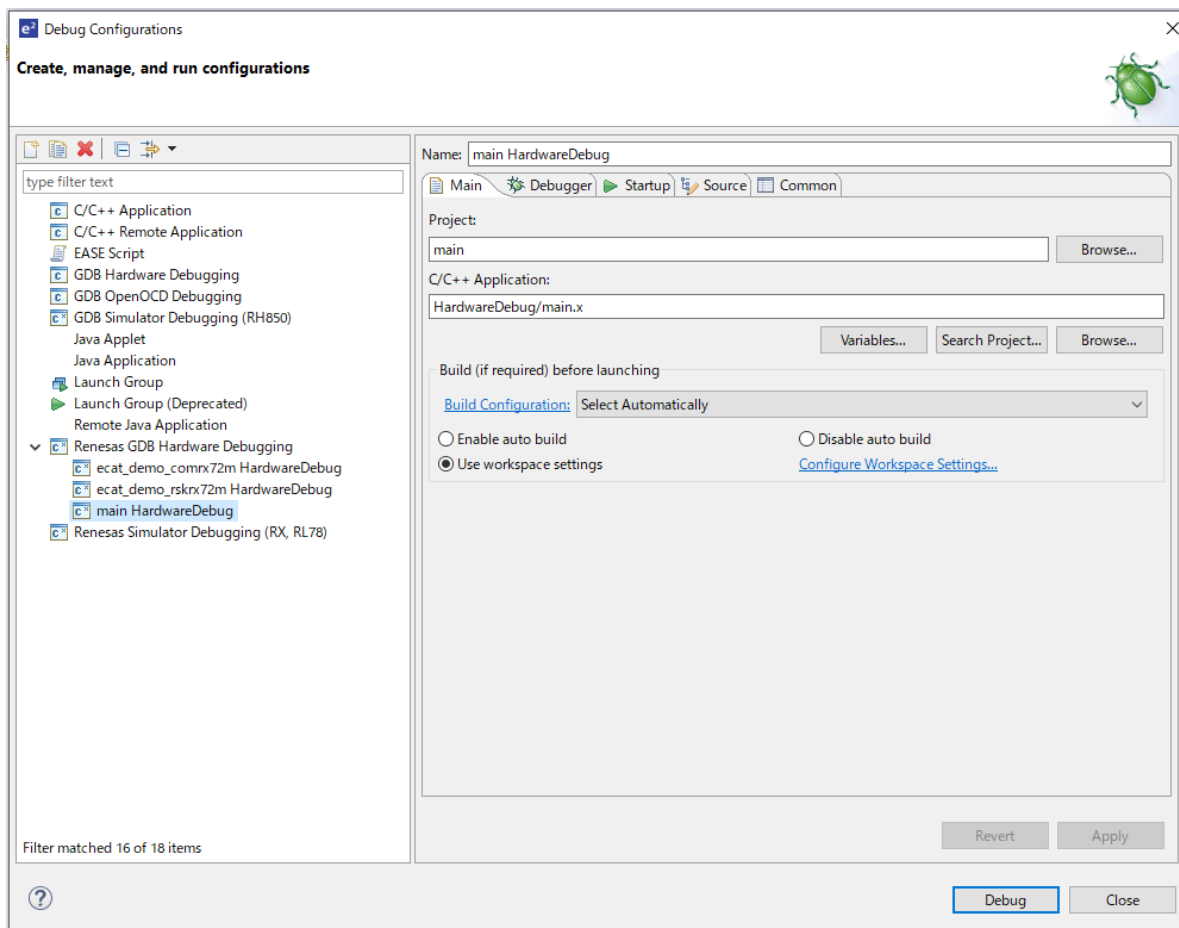
- (4) Select the "main" project in the [Project Explorer] field, select the arrow next to the [Build] button (hammer icon), and select [HardwareDebug] from the drop-down menu.



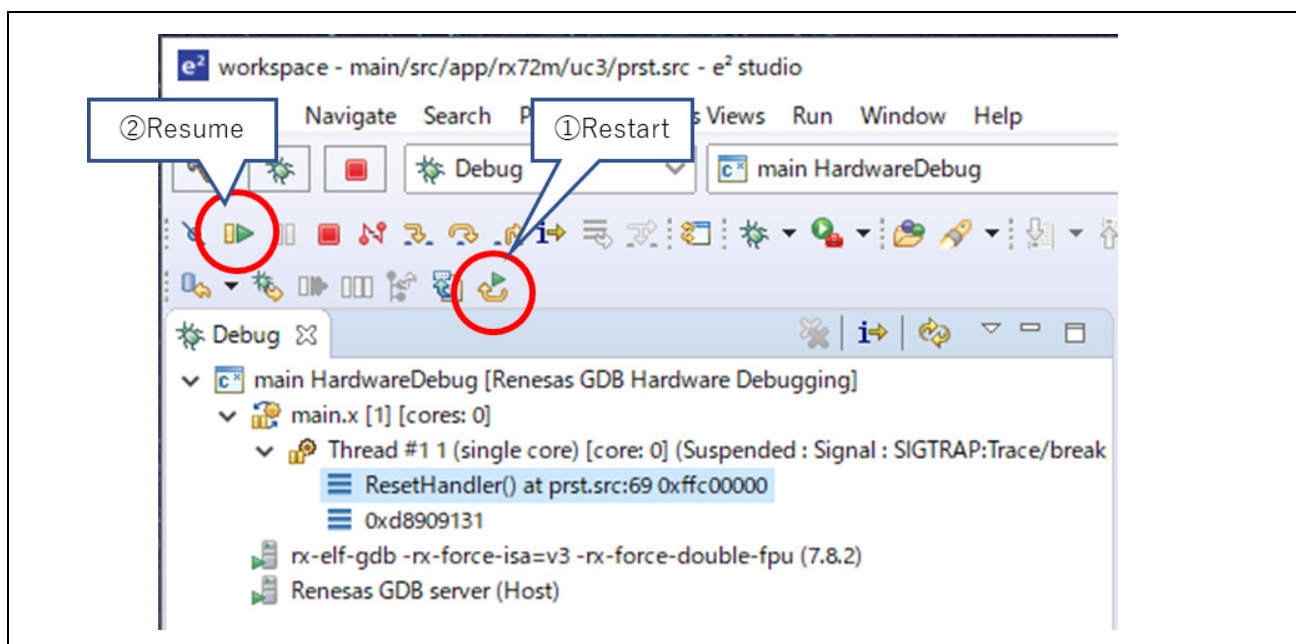
- (5) e2studio builds the project. Once the build is complete, you can start debugging by selecting the arrow next to the Debug button (bug icon) and selecting "Debug Configuration".



- (6) Select "main HardwareDebug" and select [Debug] to download the program to the target.



- (7) If a firewall warning is displayed for "e2-server-gdb.exe", check the checkbox for [Private networks, such as my home or work network] and select [Allow access].
- (8) The User Account Control (UAC) dialog box may appear. Enter the administrator's password and select [Yes].
- (9) If the Confirm Perspective Switch dialog box appears prompting you to switch the perspective, check the checkbox for [Remember my decision] and select [Yes].
- (10) The green "ACT" LED on the E2 Lite debugger will be continuously lit.
- (11) After downloading the code, select the [Resume] button to run the code. The code will break at the address where the main function starts. Select the [Resume] button again to continue to run the code.



5. Confirmation of sample project operation

This chapter describes the sample project operation check using the CODESYS software PLC.

Connect the communication board and PC according to “5.1 Connection Configuration”. Connecting the PC and USB Serial of the communication board turns on the power to the communication board.

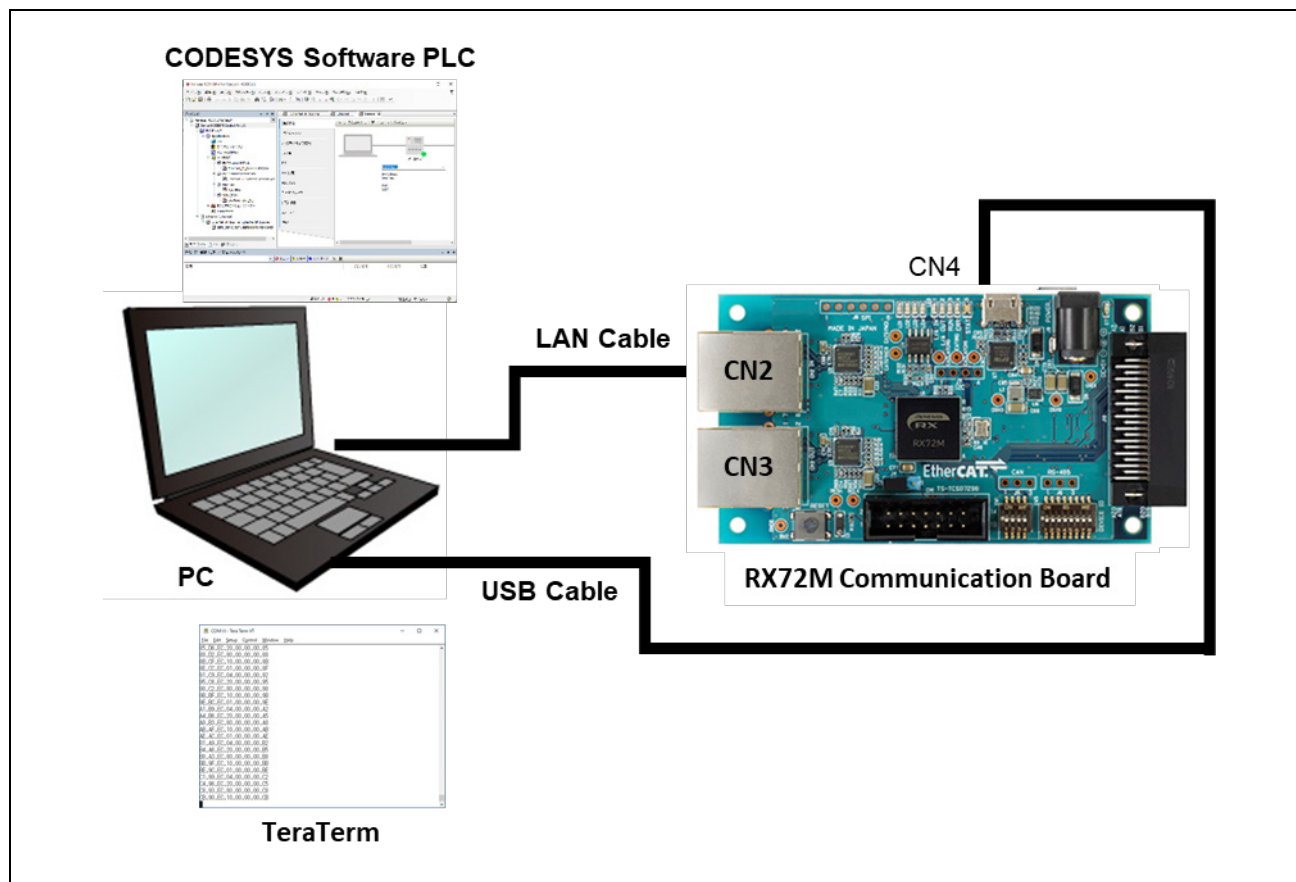


Figure 5.1 Connection configuration

5.1 Starting the CODESYS and Creating a New Project

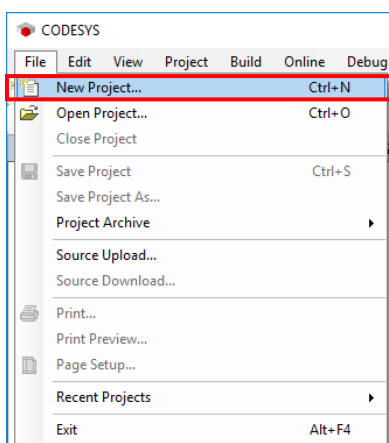
5.1.1 Starting the CODESYS

Select "All Programs" > 3S CODESYS > CODESYS > CODESYS Vx.x (x.x represents the version number) from the Windows start menu.

You can also startup the program by double-clicking on the "CODESYS" icon, which will be created on the desktop after the installation of the program.

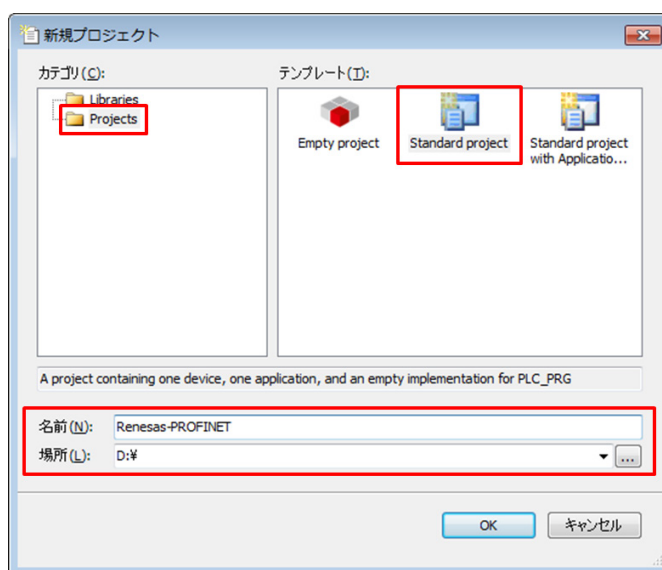
5.1.2 Creating a New Project

Select "New Project" from the "File" menu to create a new project.



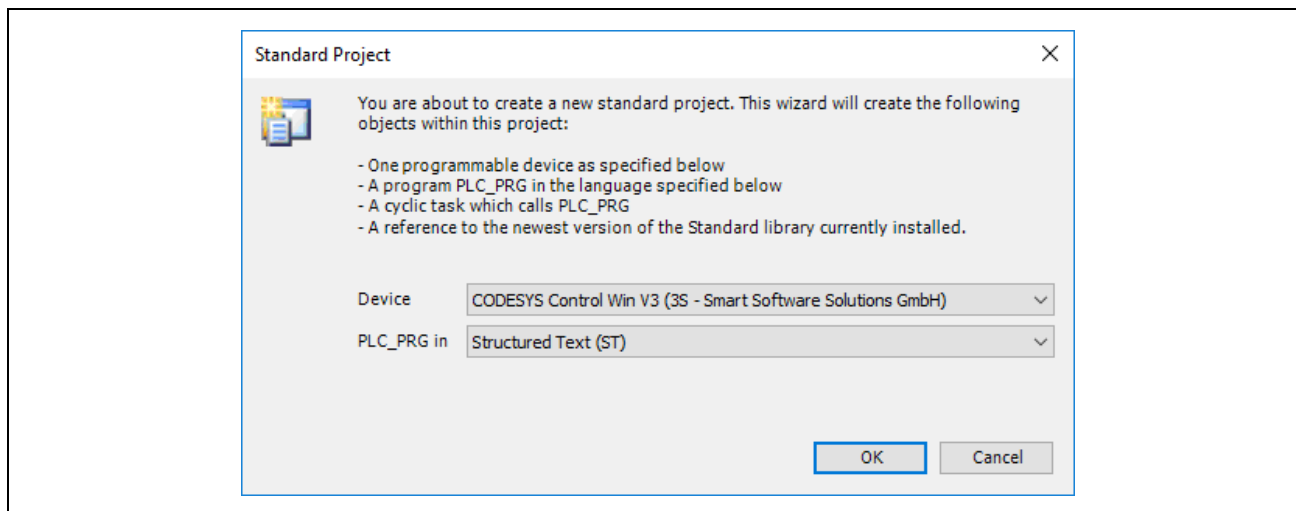
In the "New Project" window, select "Projects" from the "Categories" section and "Standard project" from the "Templates" section.

Then, specify the name of the project and its location and click on "OK".



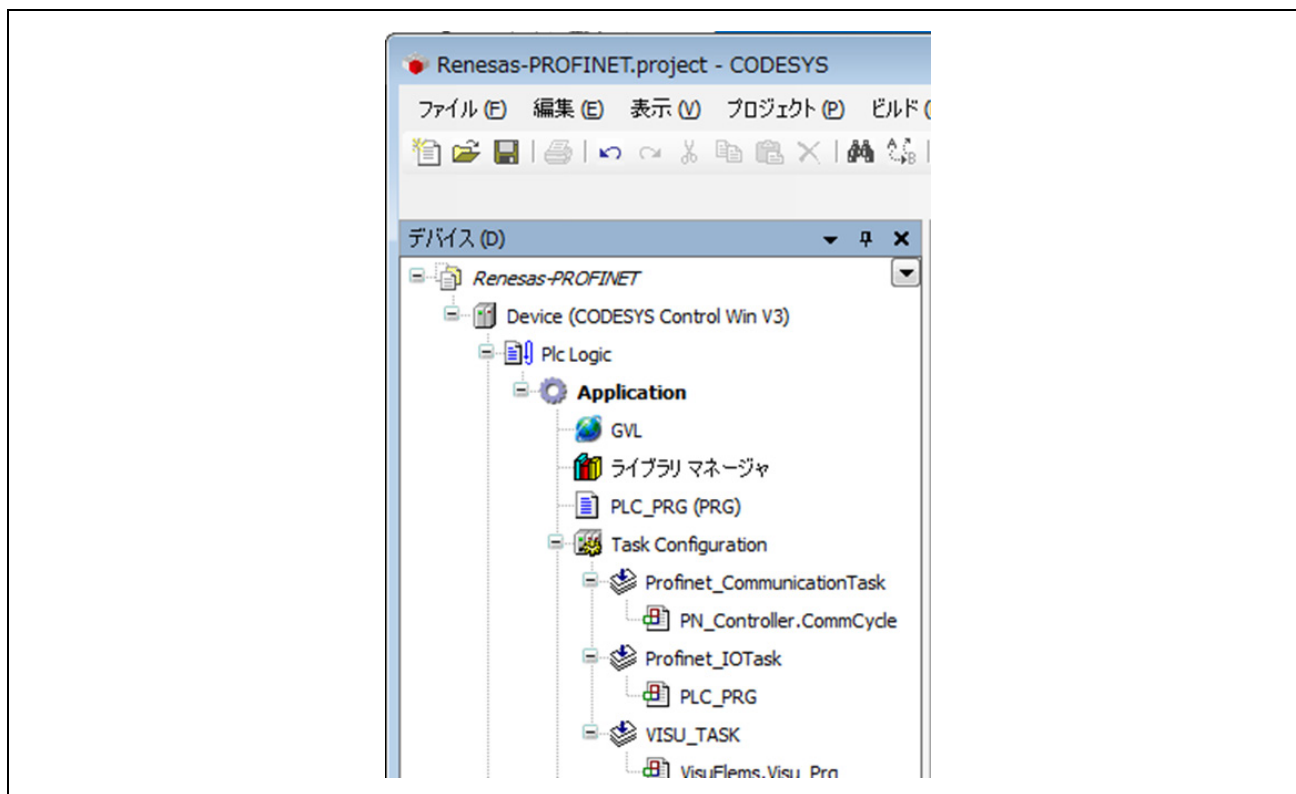
In the "Standard Project" window, select the controller and programming language you wish to use from the drop-down lists for "Device" and "PLC_PRG in". For this example, select "CODESYS Control Win V3" and "Structured Text (ST)", respectively. (If the 64-bit version is installed on the PC, select "CODESYS Control Win V3 x64")

After that, click on "OK" to open the new project



The "Device" tree for the newly created project will be displayed as shown below.

The components that belong to "Device (CODESYS Control Win V3)" are managed in a tree structure.



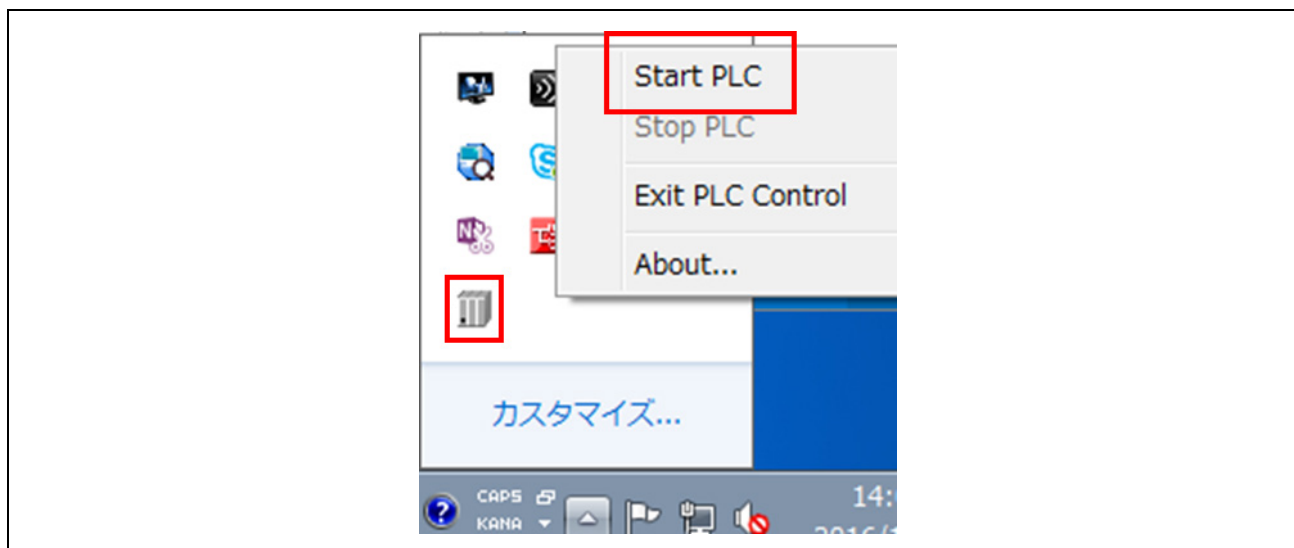
5.1.3 Starting the Gateway Server

Check the state of the gateway server on the system tray. If the server is down, click on the " " icon and select "Start Gateway" to start the server up. Usually, the server will automatically be started as a standard service on booting of Windows and its status is indicated in the system tray in the lower-right corner of the desktop.



5.1.4 Starting the Software PLC

Check the state of the software PLC on the system tray. If the program is stopped, click on the " " icon and select "Start PLC" to start the program up. Usually, the program will automatically be started as a standard service on booting of Windows and its status is indicated in the system tray in the lower-right corner of the desktop



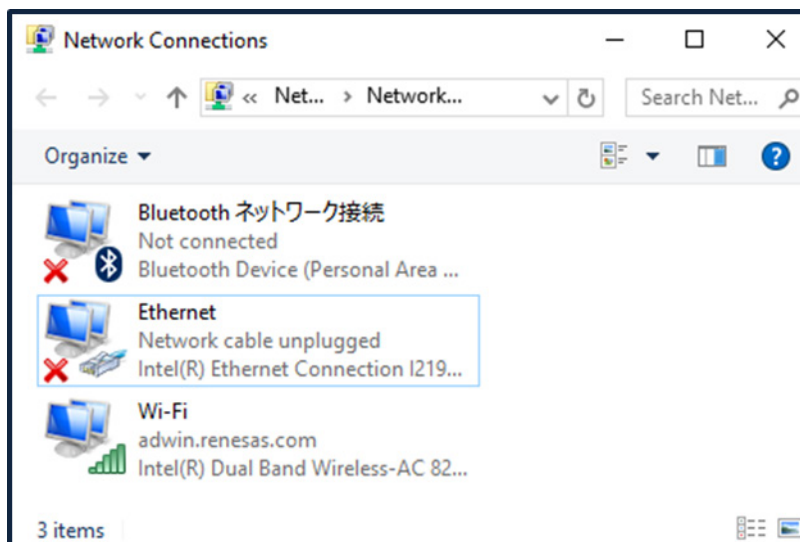
5.1.5 Configuring a Device Network

This section describes device configuration, including the setting of an IP address for use in a network of devices.

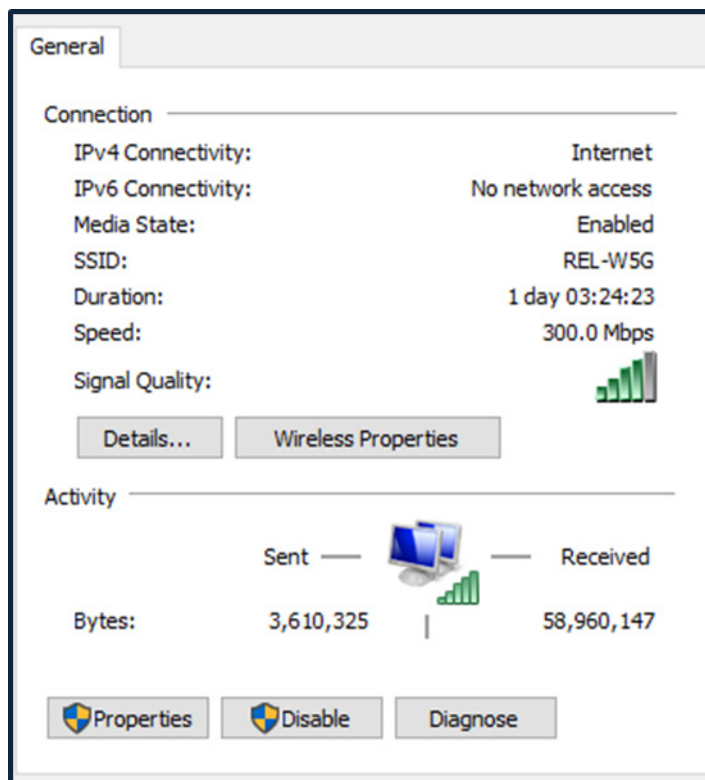
Setting the Host IP Address

Set the IP address before configuring the device.

Open "Network Connection".



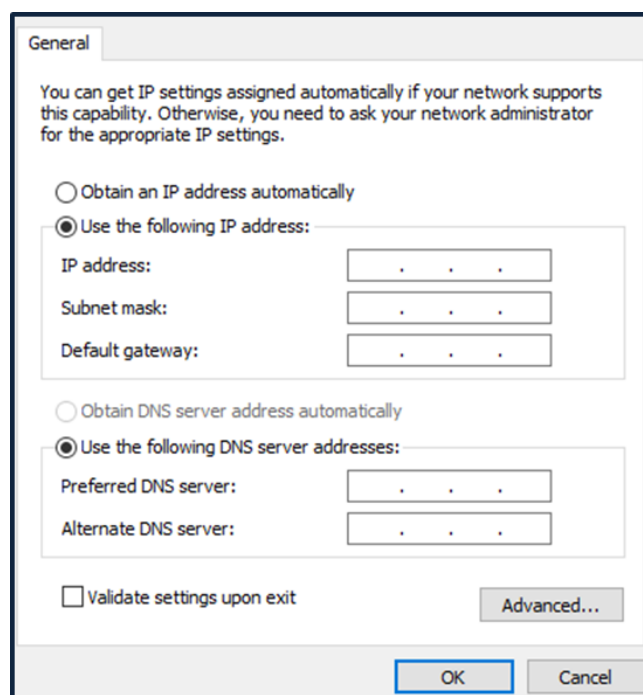
In the "Local Area Connection Status" window, select "Properties".



In the "Local Area Connection Properties" window, highlight "Internet Protocol Version 4 (TCP/IPv4)" then click on the "Properties" button.



Select the radio button "Use the following IP Address" and set IP and subnet mask. However, the network IP address should match with Device IP.

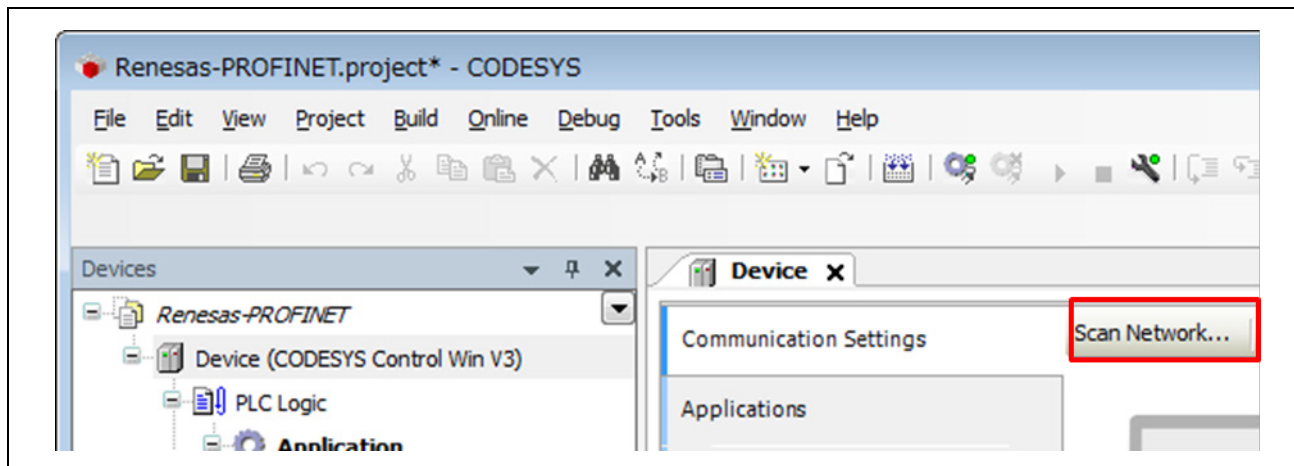


This is the end of the configuration.

5.2 Connection setting with CODESYS

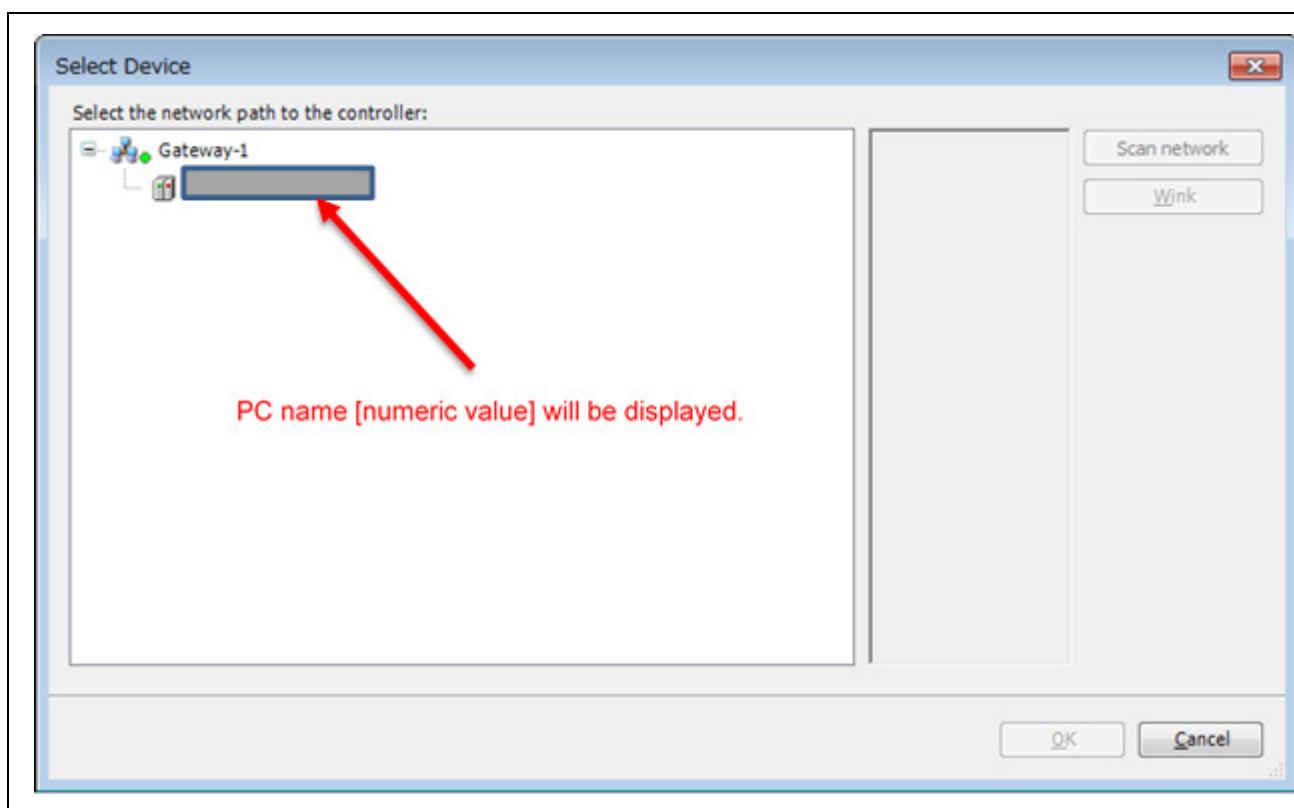
5.2.1 Select device

Make connection settings for connecting the software PLC service from your development environment. Double-click on the "Device (CODESYS Control Win V3)" in the "Device" tree. On the "Device" tabbed page, select "Connection settings" and click on the "Scan network..." button.



The "Select Device" window opens and a search for available devices that can use the local network automatically starts. Finding a software PLC service constitutes success and the name of the corresponding PC will be indicated. Double-click on the PC name to make a connection.

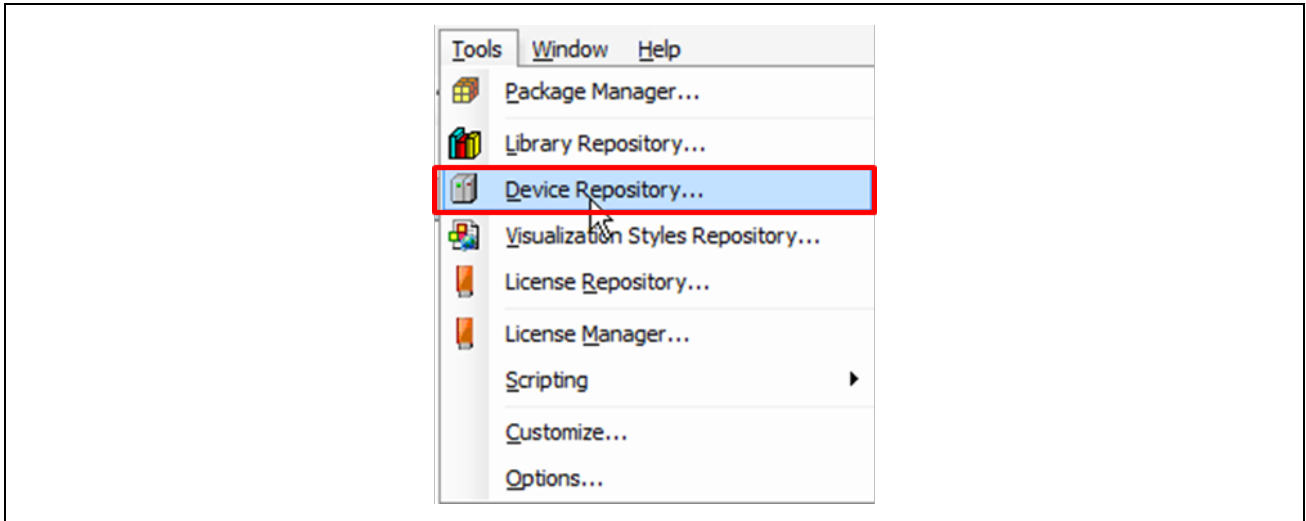
If the service will not be found, check the settings described in previous sections, (1)Starting the Gateway Server and (2)Starting the Software PLC.



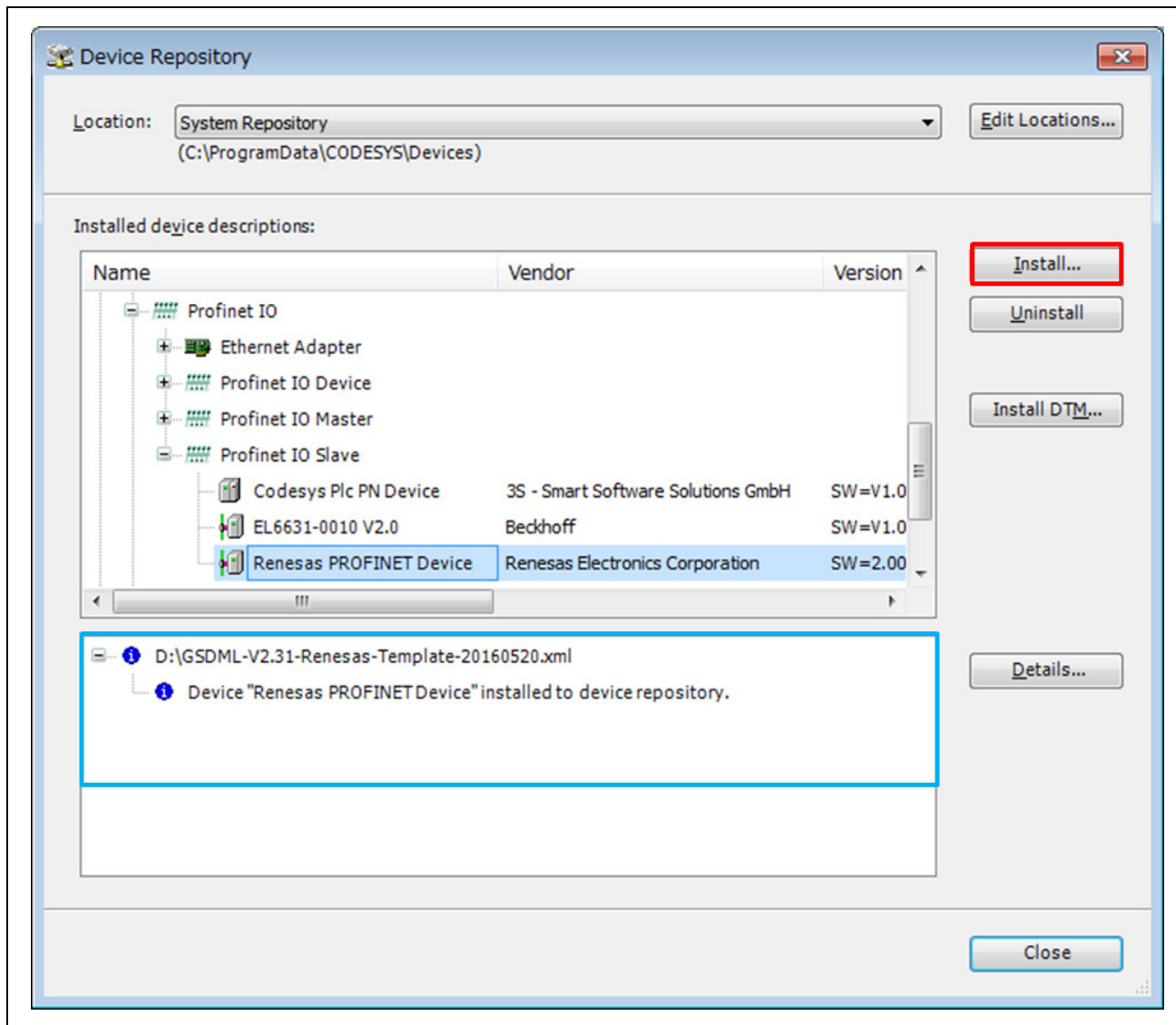
5.2.2 Installing the Device Information

Install an GSD (General Station Description) file which contains a description of the PROFINET slave device. A file for use with PROFINET is provided with the released stack.

Select "Device Repository..." from the "Tools" menu of the CODESYS program.



In the dialog box, click on the "Install" button to produce the dialog box where you are to enter the name of the provided GSD file. Specify "GSDML-V2.33-Renesas_RX72M_Dev-Sample-xxxx.xml". The result of installation will be indicated under the file name. An icon "i" appears in the case of normal installation, as is shown within the blue rectangle in the figure below

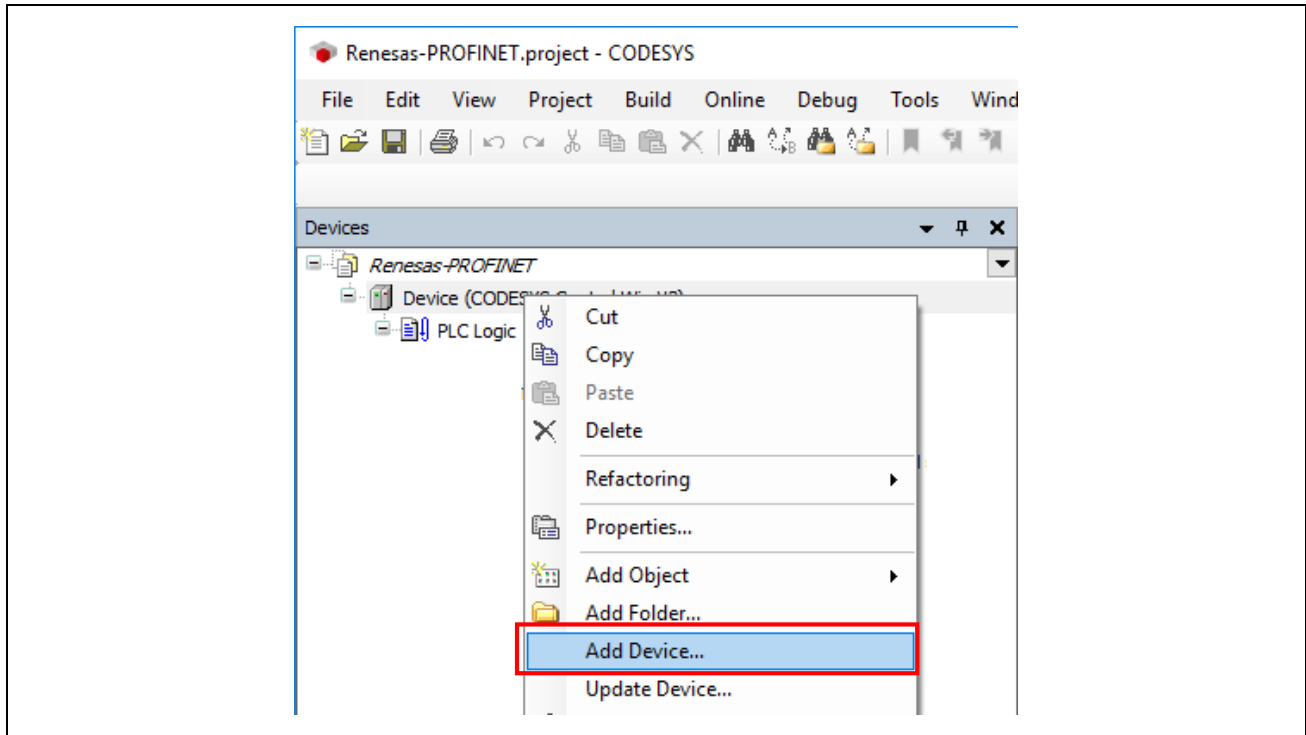


5.2.3 Adding PROFINET Device

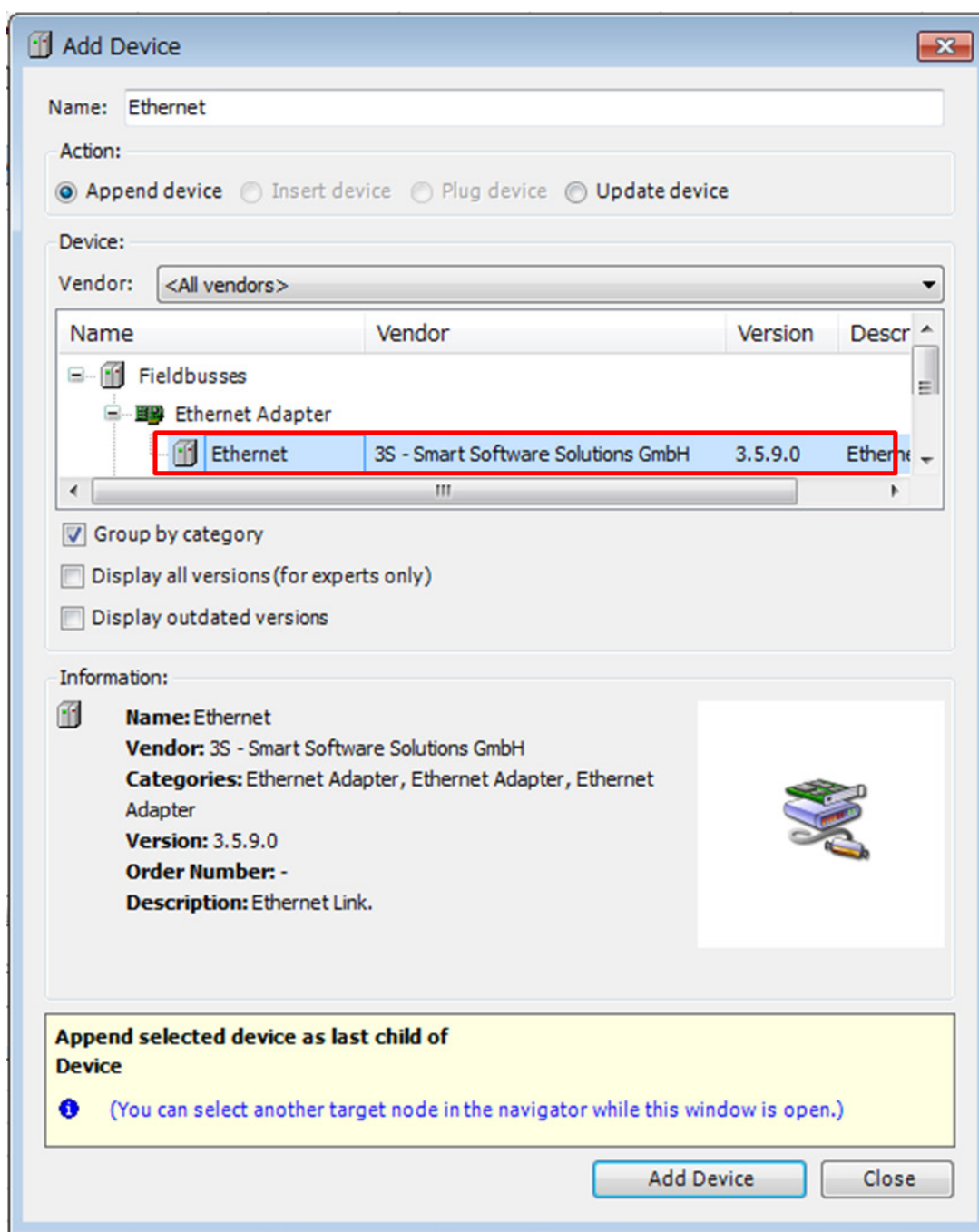
Add necessary devices to the "Device" tree.

(1) Adding Ethernet

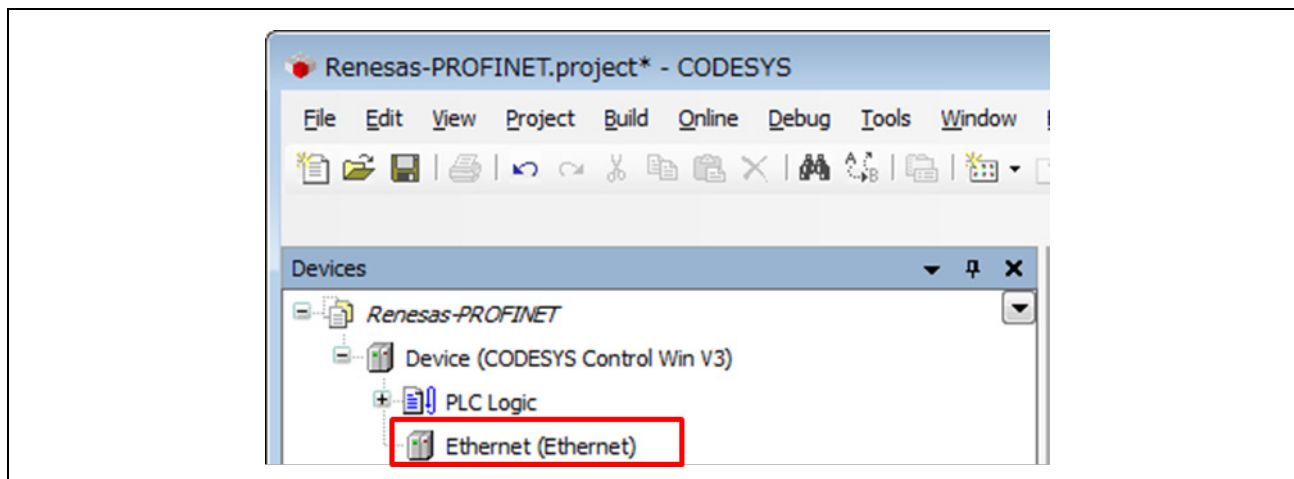
Right-click on "Device (CODESYS Control Win V3)" in the "Device" tree and select "Add Device".



The "Add Device" dialog box opens. Select "Ethernet" under "Fieldbusses", "Profinet IO", then "Ethernet Adapter" and click on the "Add Device" button.

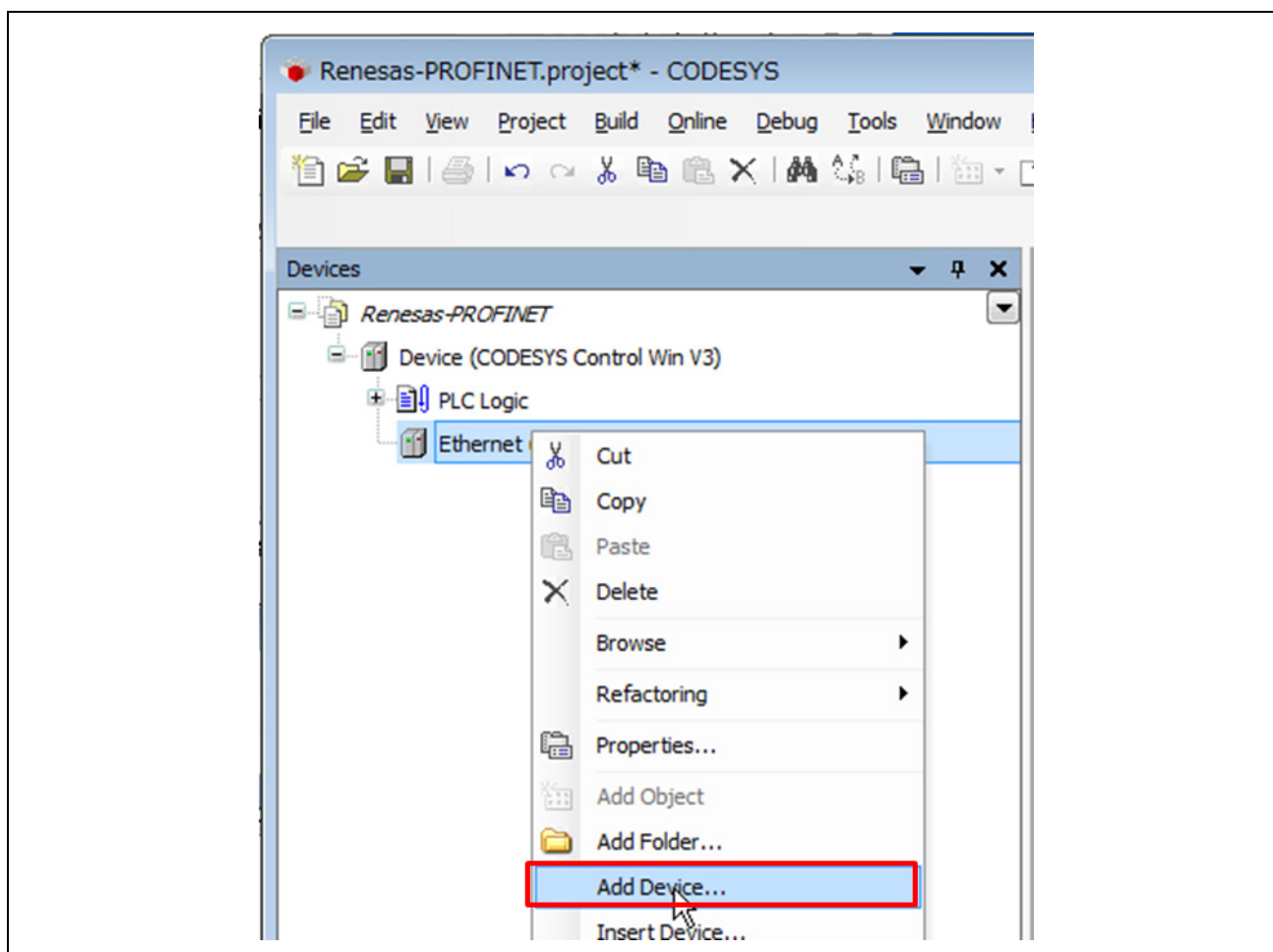


You can see that "Ethernet" has been added under "Device (CODESYS Control Win V3)" in the "Device" tree.

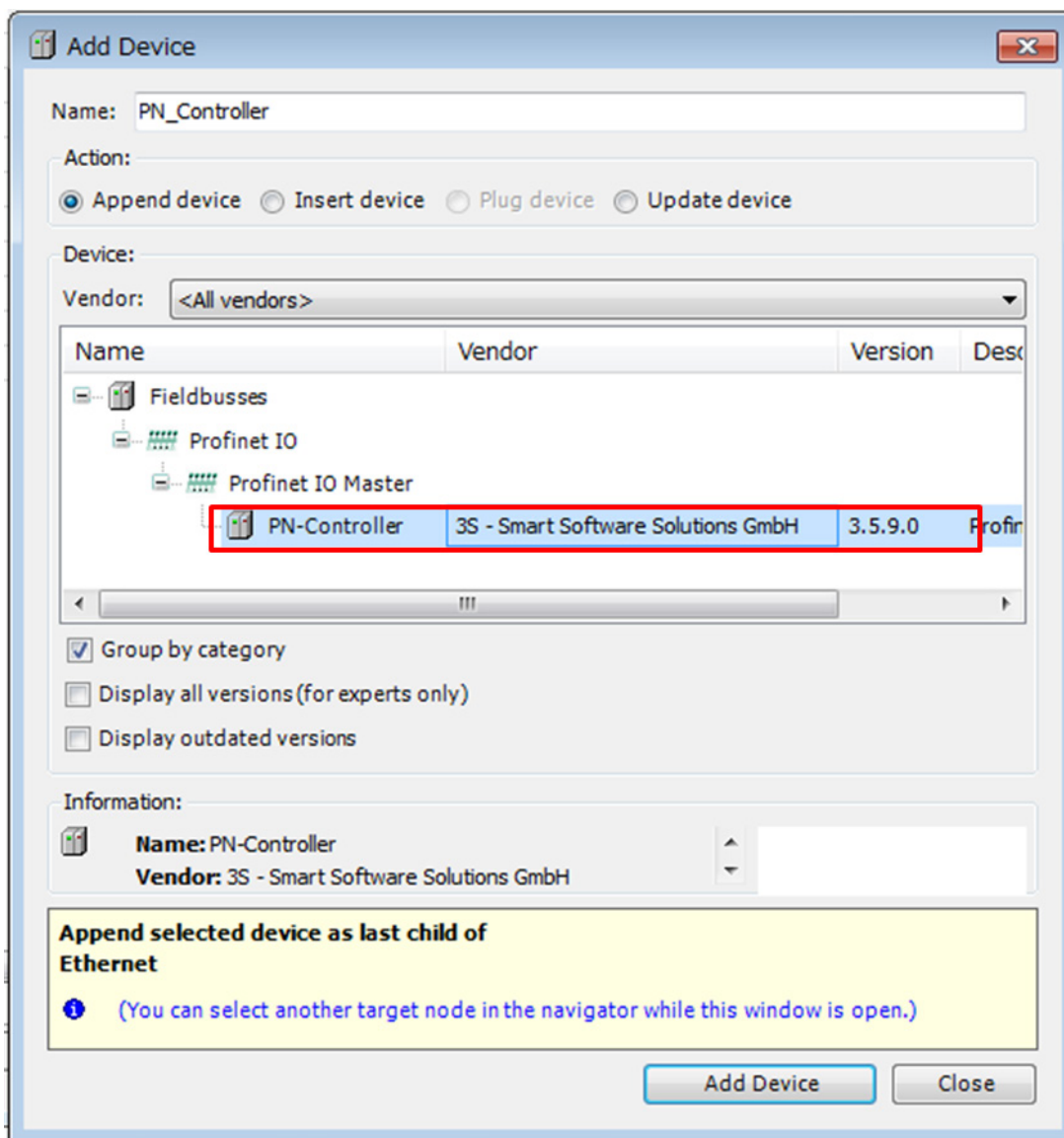


(2) Adding PN controller

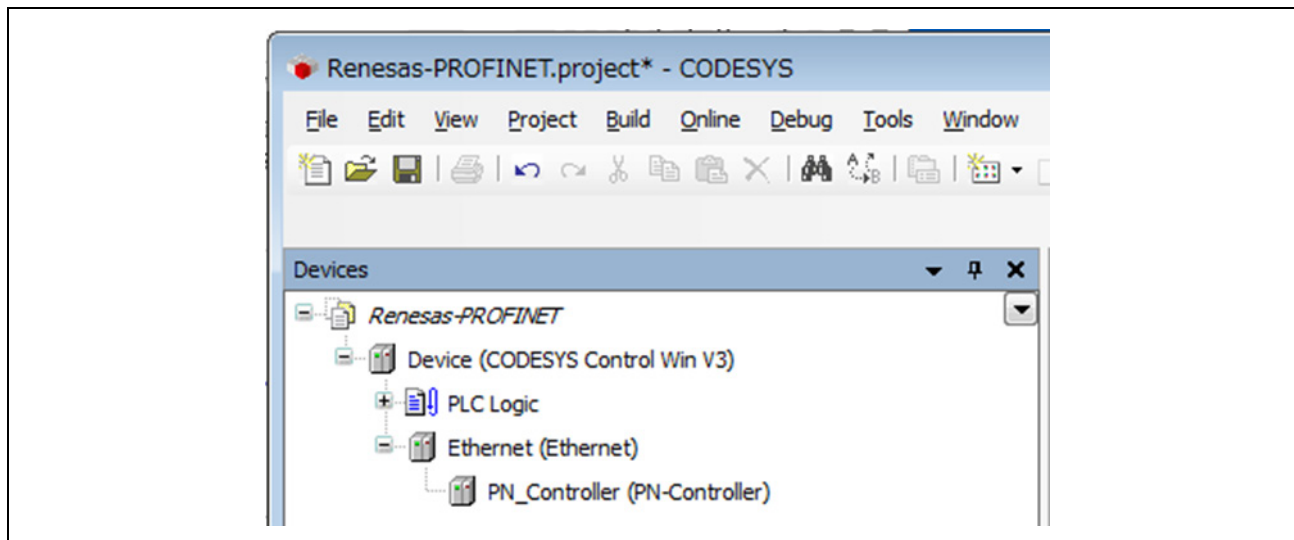
Right-click on "Ethernet (Ethernet)" in the "Device" tree and select "Add Device".



The "Add Device" dialog box opens. Select "PN-Controller" under "Fieldbusses", "Profinet IO", then "Profinet IO Master" and click on the "Add Device" button.

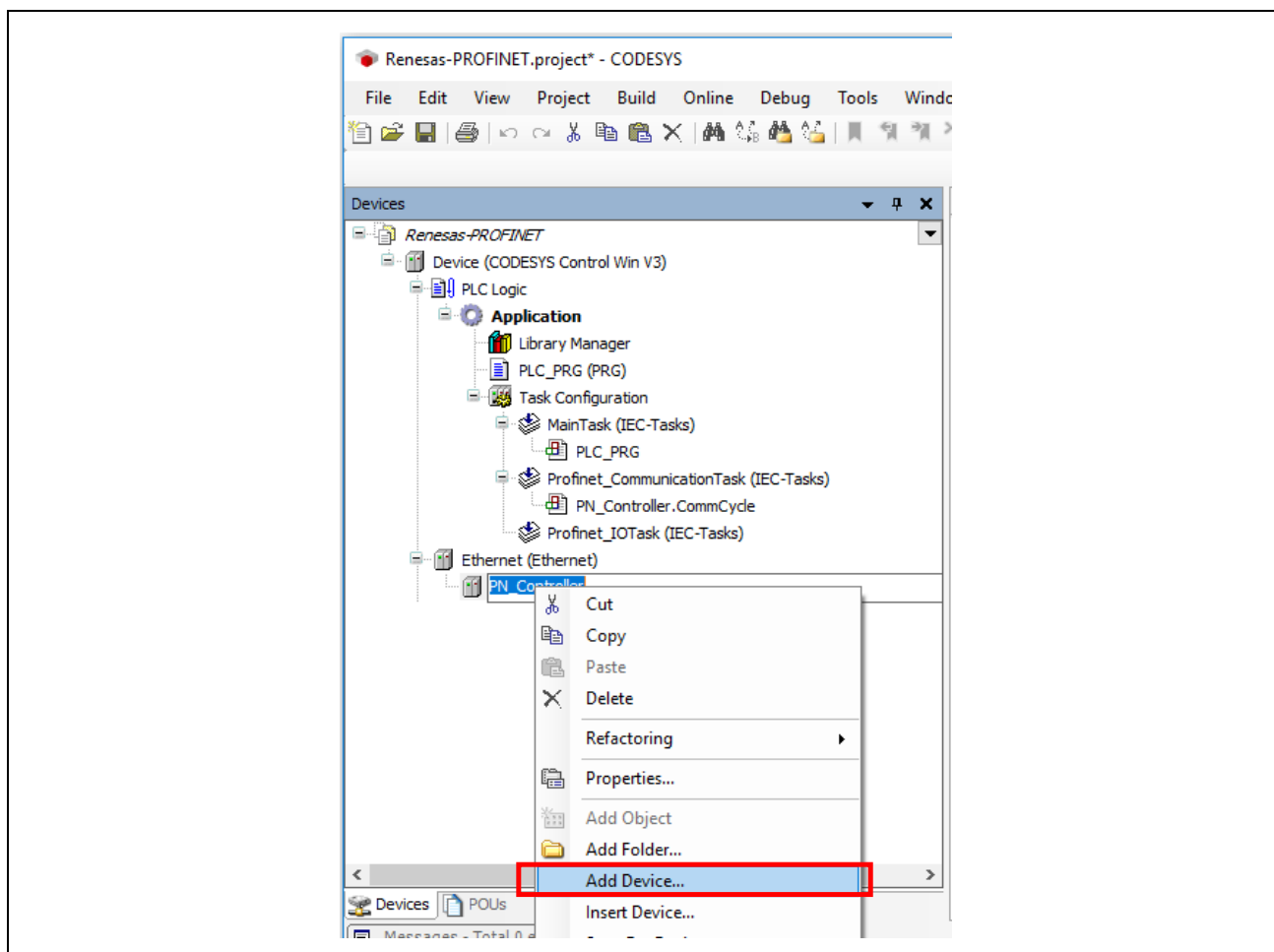


You can see that "PN-Controller" has been added under "Ethernet" in the "Device" tree.

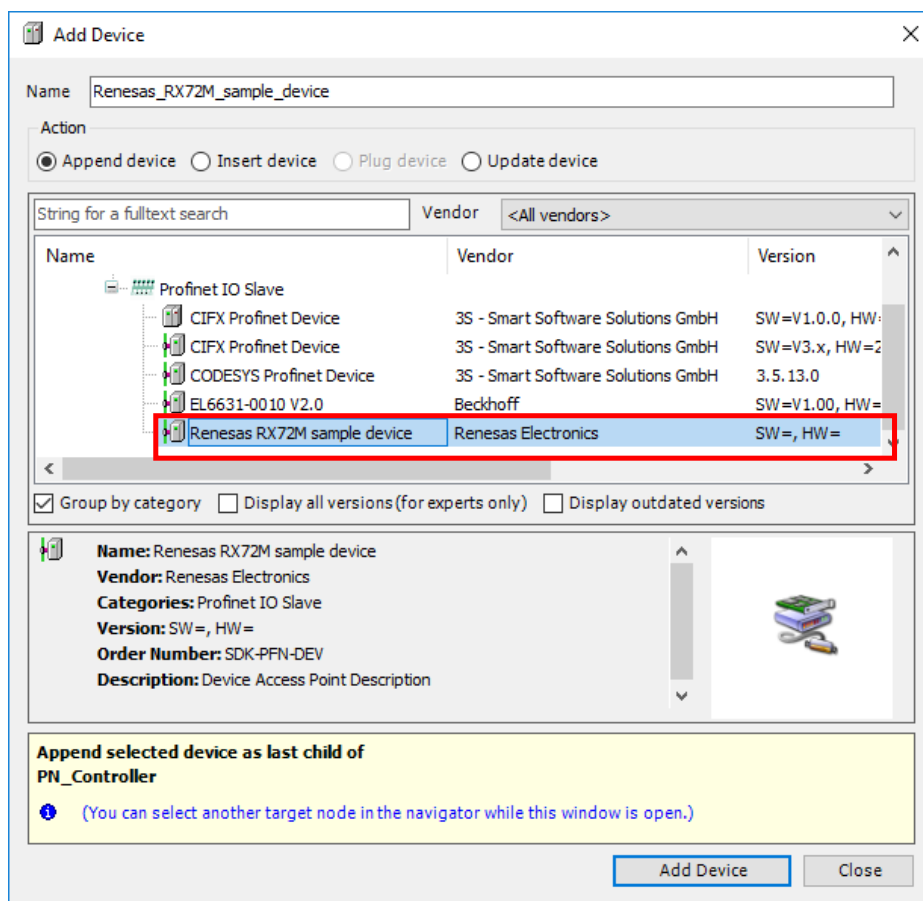


(3) Adding PROFINET Device

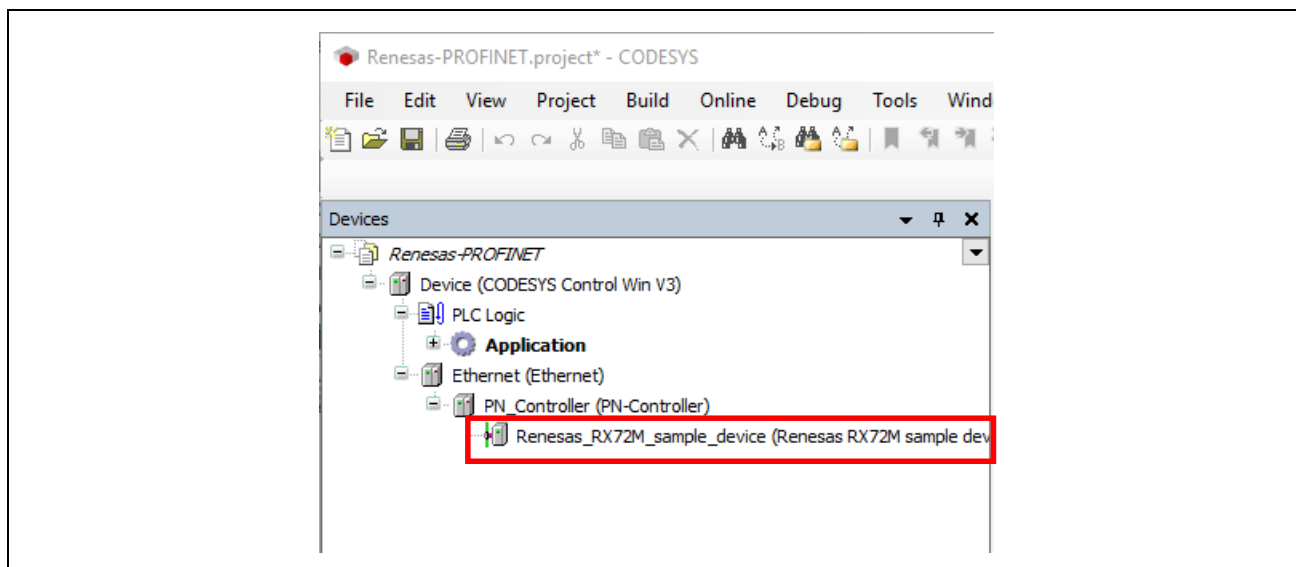
Right-click on "PN-Controller" in the "Device" tree and select "Add Device".



The "Add Device" dialog box opens. Select "Renesas RX72M sample device" under "Fieldbusses", "Profinet IO", then "Profinet IO Slave" and click on the "Add Device" button.

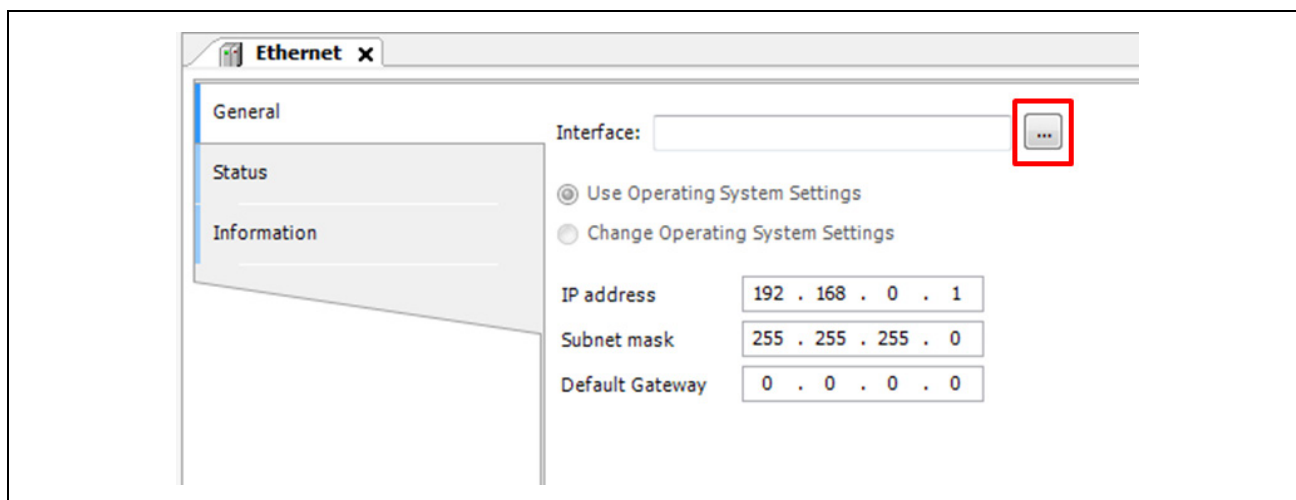


You can see that "Renesas_RX72M_sample_device" has been added under "PN-Controller" in the "Device" tree.

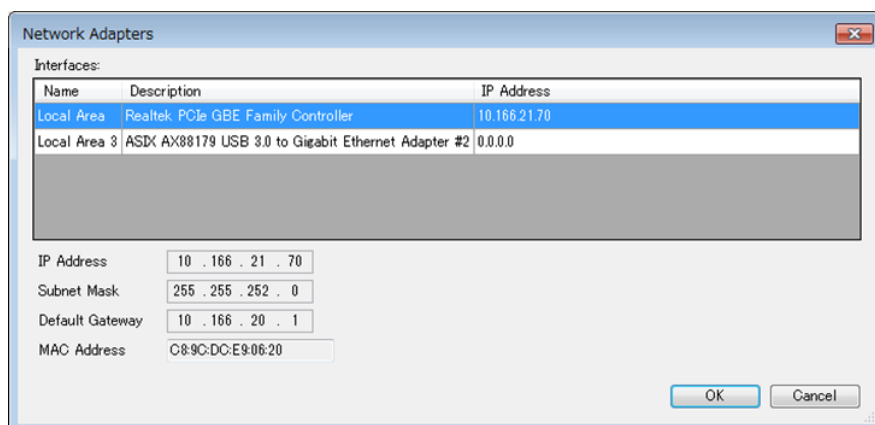


(4) Configuring the Ethernet

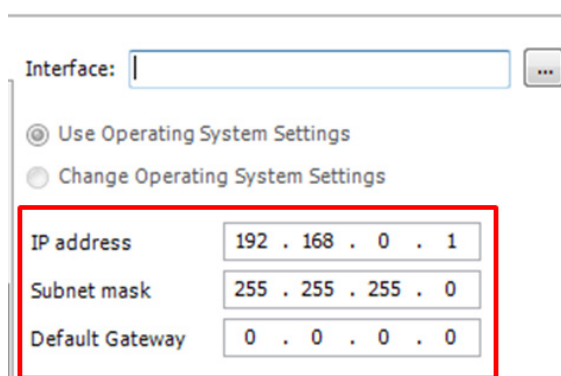
Double-click on "Ethernet (Ethernet)" in the "Device" tree to open the configuration window. In the "General" tabbed page, click on the icon next to the text box for "Interface" section as shown in a red rectangle below



In the "Network Adapters" window, select the interface you wish to use from among the interfaces offered for connection.

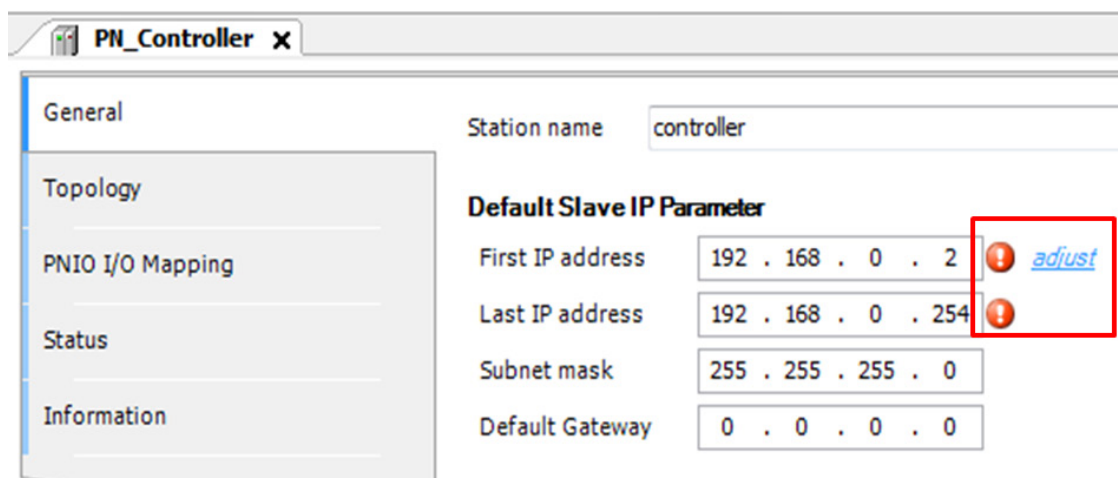


Confirm that the correct IP address is set for the interface you have selected



(5) Setting of PN-Controller

Double-click on "PN-Controller (PN-Controller)" in the "Device" tree to open the configuration window. Select the "General" tab in the window. Here, if you have configured an IP address as described in the previous section, (2) Configuring the Ethernet, if there are any applicable IP addresses, "adjust" will be indicated next to the corresponding IP address range, as shown in the red rectangle below. Clicking on this indication leads to automatic setting of the applicable IP address

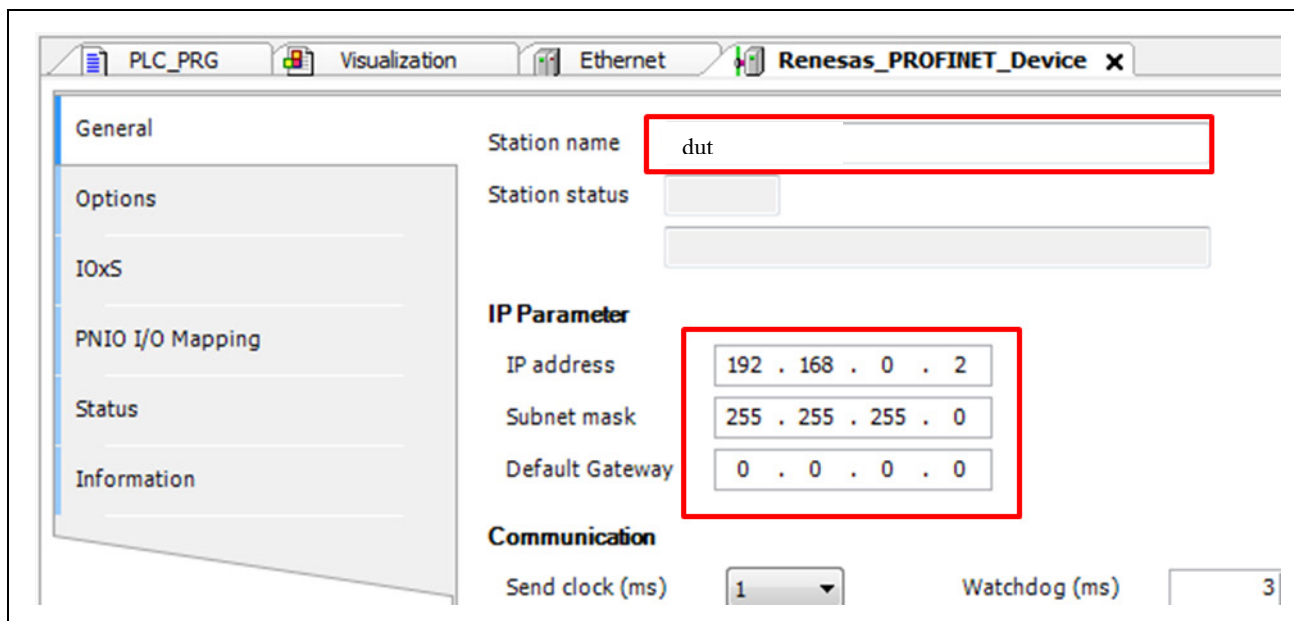


(6) Renesas_PROFINET_Device

Double-click on "Renesas_PROFINET_Device (Renesas_PROFINET_Device)" in the "Device" tree to open the configuration window. Then, select the "General" tab.

As the IP settings, specify the address ranges from "First IP address" to "Last IP address" you have configured according to the description in the previous section, (3) PN-Controller.

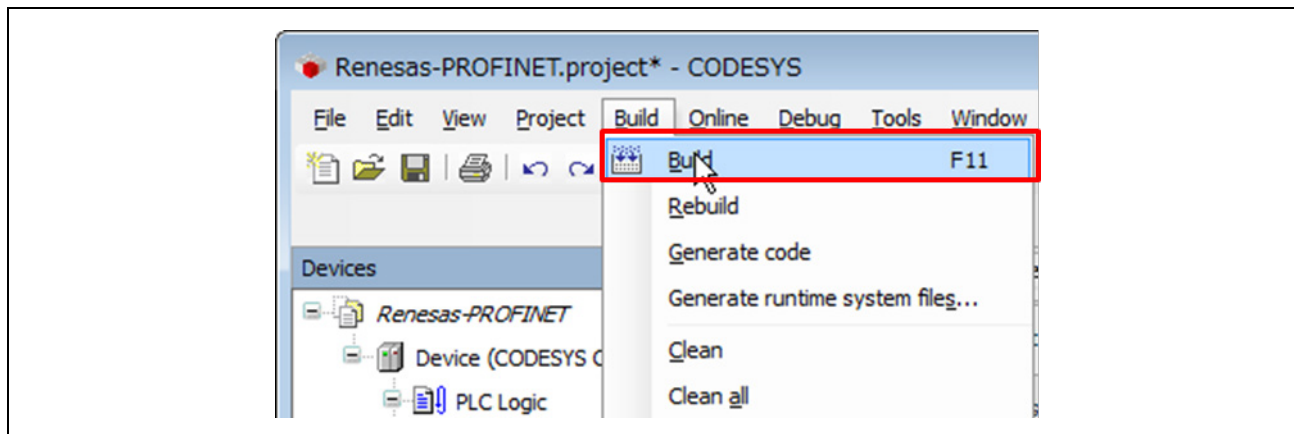
The PROFINET system recognizes slave devices by the names specified in the "Station name" section of this page. Enter the station name set within the slave device



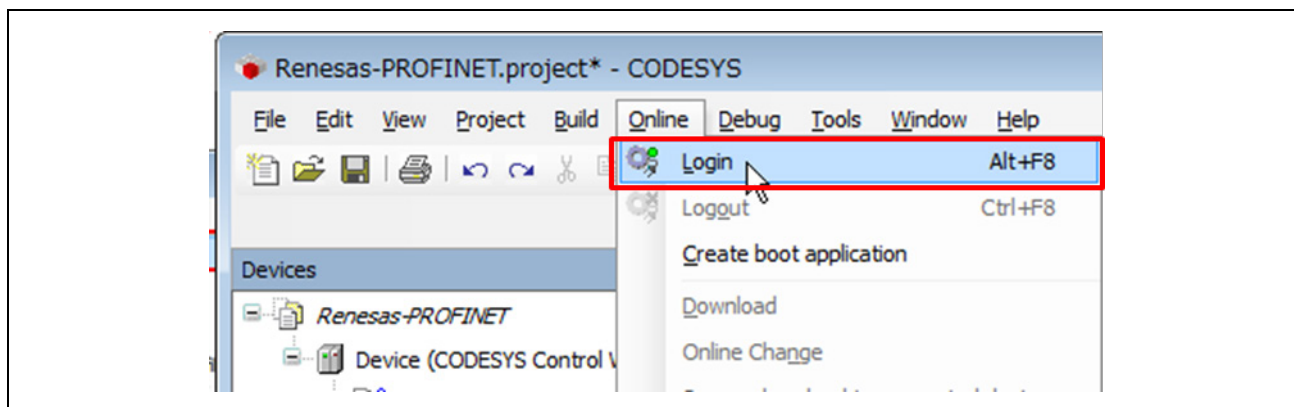
5.3 Connection confirmation with CODESYS

This section describes how to run a program on the CODESYS development environment and how to ensure connection of the device.

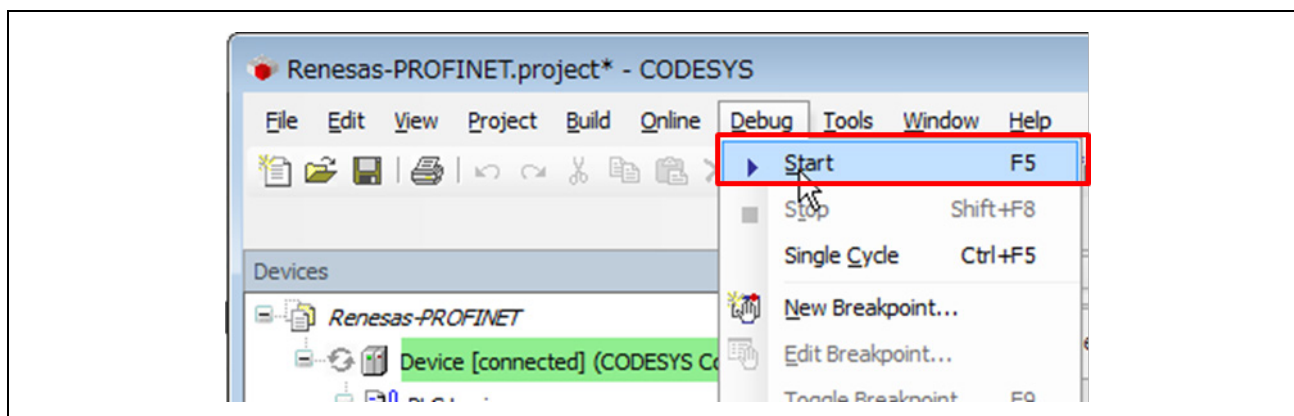
Select "Build" from the "Build" menu.




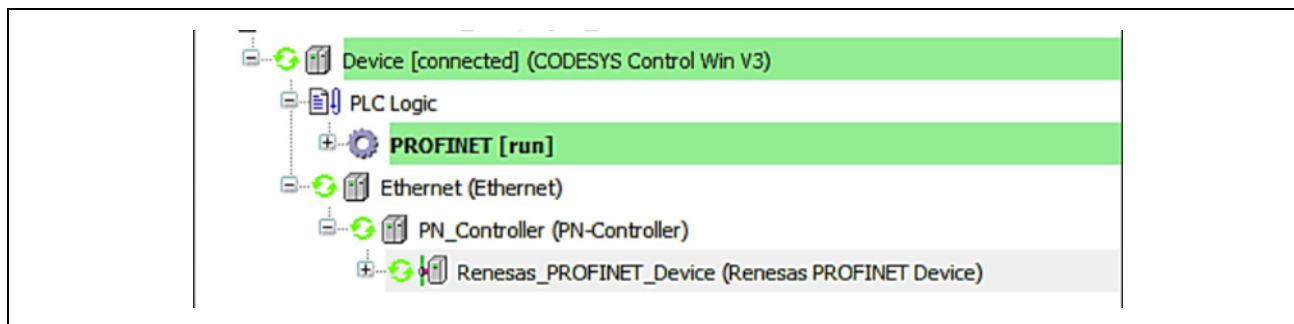
Select "Login" from the "Online" menu



Select "Start" from the "Debug" menu. The project will automatically start on Windows



The states of connection will be indicated next to each device name. Successful connection is indicated by the "  " icon as shown in the tree view below



The icons indicating status of each device is listed below.



: The application is connected to the PLC and is running.



: The application is connected to the PLC but is not running.



: Error. Check the error contents and the settings of the device.



: There is no device information in the device repository. Review the device information file and re-install it.

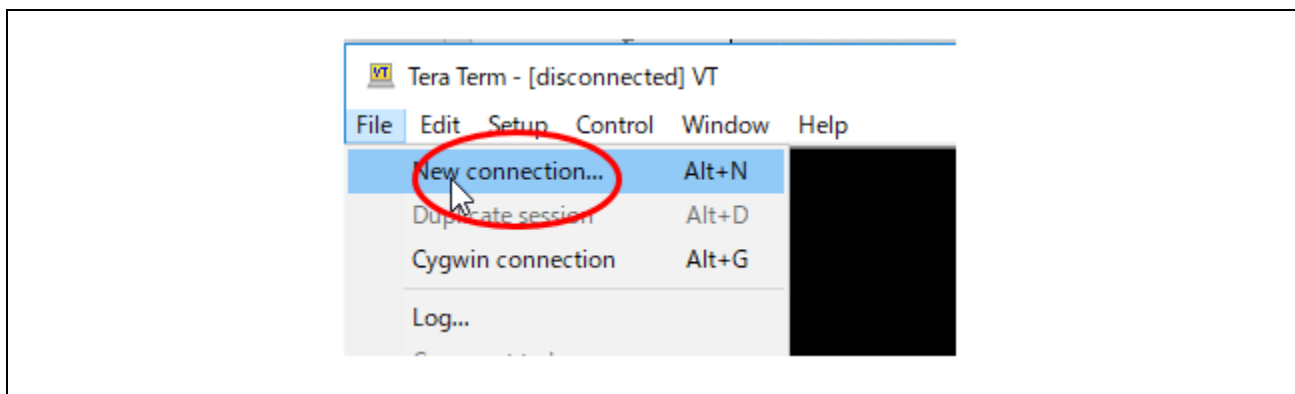
6. Debug function

The debug function is described below.

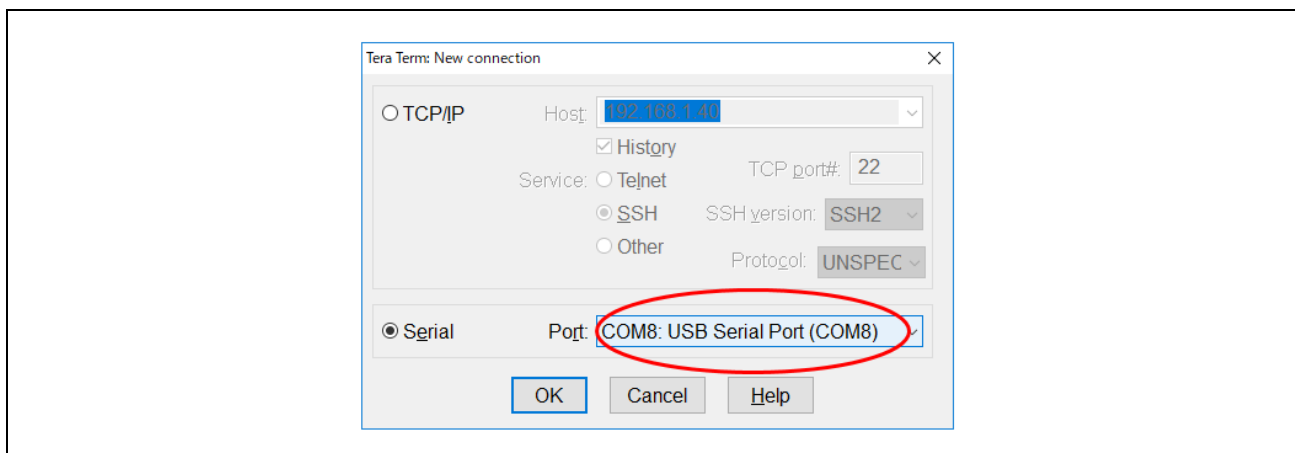
6.1 Terminal software settings

Debug logs can be output via USB Serial (CN4).

- (1) Start the "Tera Term", press the "new connection" in the "File", and then select the COM port.



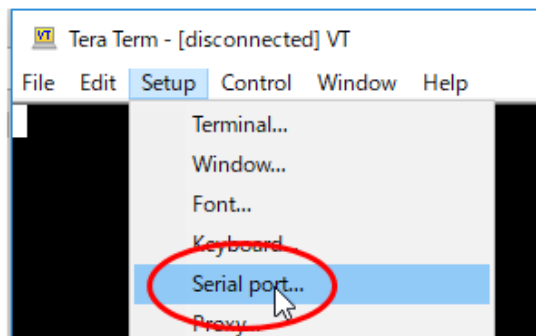
- (2) Select the USB serial port for log output.



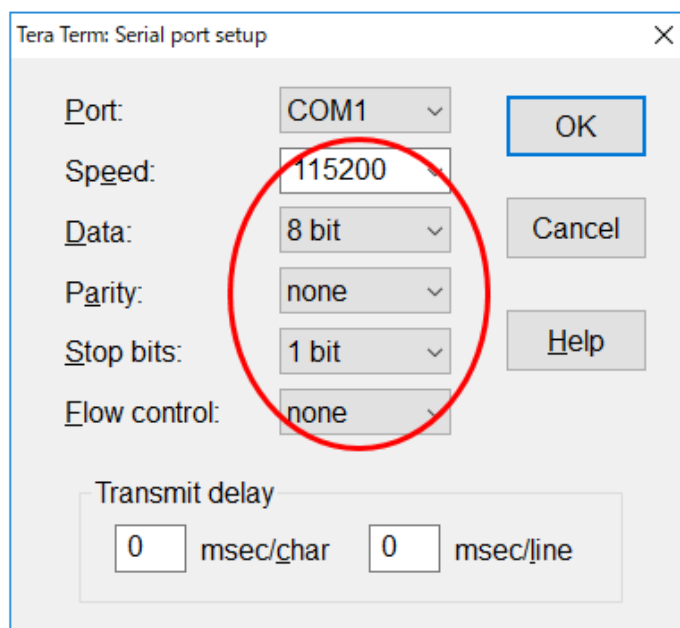
note

It is different from the port for communication.

- (3) Set serial communication parameters from "Serial Port" in "Settings".



- (4) Configure the serial port settings as shown in Figure 5.14.



6.2 MAC address / IP Address confirmation method

The MAC Address / IP Address confirmation method is described below.

The following command

“ipconfig”

MAC Address / IP Address can be confirmed by typing from the console.

■ ipconfig displayed terminal.

```
=====
ipconfig
IPAddr = 192.168.0.50
NetMask = 255.255.255.0
Gateway = 192.168.0.50
=====
```

6.3 Heap confirmation method

The Heap confirmation method is described below.

The following command

“Heapstat”

Heap can be confirmed by typing from the console.

■ Heapstat displayed terminal

```
=====
Heapstat
PNET free memory = 51672 / 262144 byte
OSW free memory = 32297 / 32768 byte
=====
```

7. Test Option

Describe the test options.

When the option "PROFINET_IO_DEBUG_IN_TO_OUT" of the following file is enabled, the data written in the input buffer of periodic communication is written to the output buffer as it is.
This option is disabled (0) by default.

pnet_dev\src\app\rx72m\Application\pniod_app_api.h

Revision History

		Description	
Rev.	Date	Page	Summary
1.00	Aug. 31, 2019	-	First edition issued
1.01	Dec. 5, 2019	9	Fix misstatements of uC3 folder names
1.02	May 22, 2020	9	Updated words, images
		20	Added information
		37	Fixed the command
1.03	Aug. 31, 2020	3	Operating environment changed due to stack support for 2 ports
		4	Folder structure changed due to stack bundling
		9	Change the sample build due to stack bundling
1.04	Aug. 31, 2021	-	TMG Stack update v5.4.4.0 → v5.5.0.0
		-	Certification test Test Bundle "2020-05-07_PN-test" compatible
		-	Support for CC-B
		-	SNMP support
		-	Changed the number of slots from 8 to 4 to reduce ROM/RAM
		-	CRC32 compatible for non-volatile memory verification
		-	Fixed the process of displaying the initial value on the TCP / IP stack with the console command "ipconfig".
		-	Support with one Ethernet port
		36	Added test options

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity.

Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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